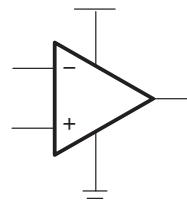


TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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- Supply Current . . . 23 μ A/Channel
- Gain-Bandwidth Product . . . 220 kHz
- Output Drive Capability . . . ± 10 mA
- Input Offset Voltage . . . 20 μ V (typ)
- V_{DD} Range . . . 2.7 V to 6 V
- Power Supply Rejection Ratio . . . 106 dB
- Ultralow-Power Shutdown Mode
 I_{DD} . . . 16 nA/ch
- Rail-To-Rail Input/Output (RRIO)
- Ultrasmall Packaging
 - 5 or 6 Pin SOT-23 (TLV2450/1)
 - 8 or 10 Pin MSOP (TLV2452/3)

Operational Amplifier



description

The TLV245x is a family of rail-to-rail input/output operational amplifiers that sets a new performance point for supply current and ac performance. These devices consume a mere 23 μ A/channel while offering 220 kHz of gain-bandwidth product, much higher than competitive devices with similar supply current levels. Along with increased ac performance, the amplifier provides high output drive capability, solving a major shortcoming of older micropower rail-to-rail input/output operational amplifiers. The TLV245x can swing to within 250 mV of each supply rail while driving a 2.5-mA load. Both the inputs and outputs swing rail-to-rail for increased dynamic range in low-voltage applications. This performance makes the TLV245x family ideal for portable medical equipment, patient monitoring systems, and data acquisition circuits.

FAMILY PACKAGE TABLE

DEVICE	NUMBER OF CHANNELS	PACKAGE TYPES					SHUTDOWN	UNIVERSAL EVM BOARD
		PDIP	SOIC	SOT-23	TSSOP	MSOP		
TLV2450	1	8	8	6	—	—	Yes	Refer to the EVM Selection Guide (Lit# SLOU060)
TLV2451	1	8	8	5	—	—	—	
TLV2452	2	8	8	—	—	8	—	
TLV2453	2	14	14	—	—	10	Yes	
TLV2454	4	14	14	—	14	—	—	
TLV2455	4	16	16	—	16	—	Yes	

A SELECTION OF SINGLE-SUPPLY OPERATIONAL AMPLIFIER PRODUCTS[†]

DEVICE	V_{DD} (V)	BW (MHz)	SLEW RATE (V/ μ s)	I_{DD} (per channel) (μ A)	RAIL-TO-RAIL
TLV245X	2.7 – 6.0	0.22	0.11	23	I/O
TLV247X	2.7 – 6.0	2.8	1.5	600	I/O
TLV246X	2.7 – 6.0	6.4	1.6	550	I/O
TLV277X	2.5 – 6.0	5.1	10.5	1000	O

[†] All specifications measured at 5 V.



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TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA

FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT

OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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description (continued)

Three members of the family (TLV2450/3/5) offer a shutdown terminal for conserving battery life in portable applications. During shutdown, the outputs are placed in a high-impedance state and the amplifier consumes only 16 nA/channel. The family is fully specified at 3 V and 5 V across an expanded industrial temperature range (-40°C to 125°C). The singles and duals are available in the SOT23 and MSOP packages, while the quads are available in TSSOP. The TLV2450 offers an amplifier with shutdown functionality all in a 6-pin SOT23 package, making it perfect for high density circuits.

TLV2450 and TLV2451 AVAILABLE OPTIONS

T _A	PACKAGED DEVICES			
	SMALL OUTLINE (D) [†]	SOT-23		PLASTIC DIP (P)
		(DBV)	SYMBOL	
0°C to 70°C	TLV2450CD TLV2451CD	TLV2450CDBV TLV2451CDBV	VAQC VARC	TLV2450CP TLV2451CP
-40°C to 125°C	TLV2450ID TLV2451ID	TLV2450IDBV TLV2451IDBV	VAQI VARI	TLV2450IP TLV2451IP
	TLV2450AID TLV2451AID	— —	— —	TLV2450AIP TLV2451AIP

[†] This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2450CDR).

TLV2452 and TLV2453 AVAILABLE OPTIONS

T _A	PACKAGED DEVICES						
	SMALL OUTLINE (D) [†]	MSOP				PLASTIC DIP (N)	PLASTIC DIP (P)
		(DGK) [†]	SYMBOL [‡]	(DGS) [†]	SYMBOL [‡]		
0°C to 70°C	TLV2452CD TLV2453CD	TLV2452CDGK —	xxTIABI —	— TLV2453CDGS	— xxTIABK	— TLV2453CN	TLV2452CP —
-40°C to 125°C	TLV2452ID TLV2453ID	TLV2452IDGK —	xxTIABJ —	— TLV2453IDGS	— xxTIABL	— TLV2453IN	TLV2452IP —
	TLV2452AID TLV2453AID	— —	— —	— —	— —	— TLV2453AIN	TLV2452AIP —

[†] This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2452CDR).

[‡] xx represents the device date code.

TLV2454 and TLV2455 AVAILABLE OPTIONS

T _A	PACKAGED DEVICES		
	SMALL OUTLINE (D) [†]	PLASTIC DIP (N)	TSSOP (PW) [†]
0°C to 70°C	TLV2454CD TLV2455CD	TLV2454CN TLV2455CN	TLV2454CPW TLV2455CPW
-40°C to 125°C	TLV2454ID TLV2455ID	TLV2454IN TLV2455IN	TLV2454IPW TLV2455IPW
	TLV2454AID TLV2455AID	TLV2454AIN TLV2455AIN	TLV2454AIPW TLV2455AIPW

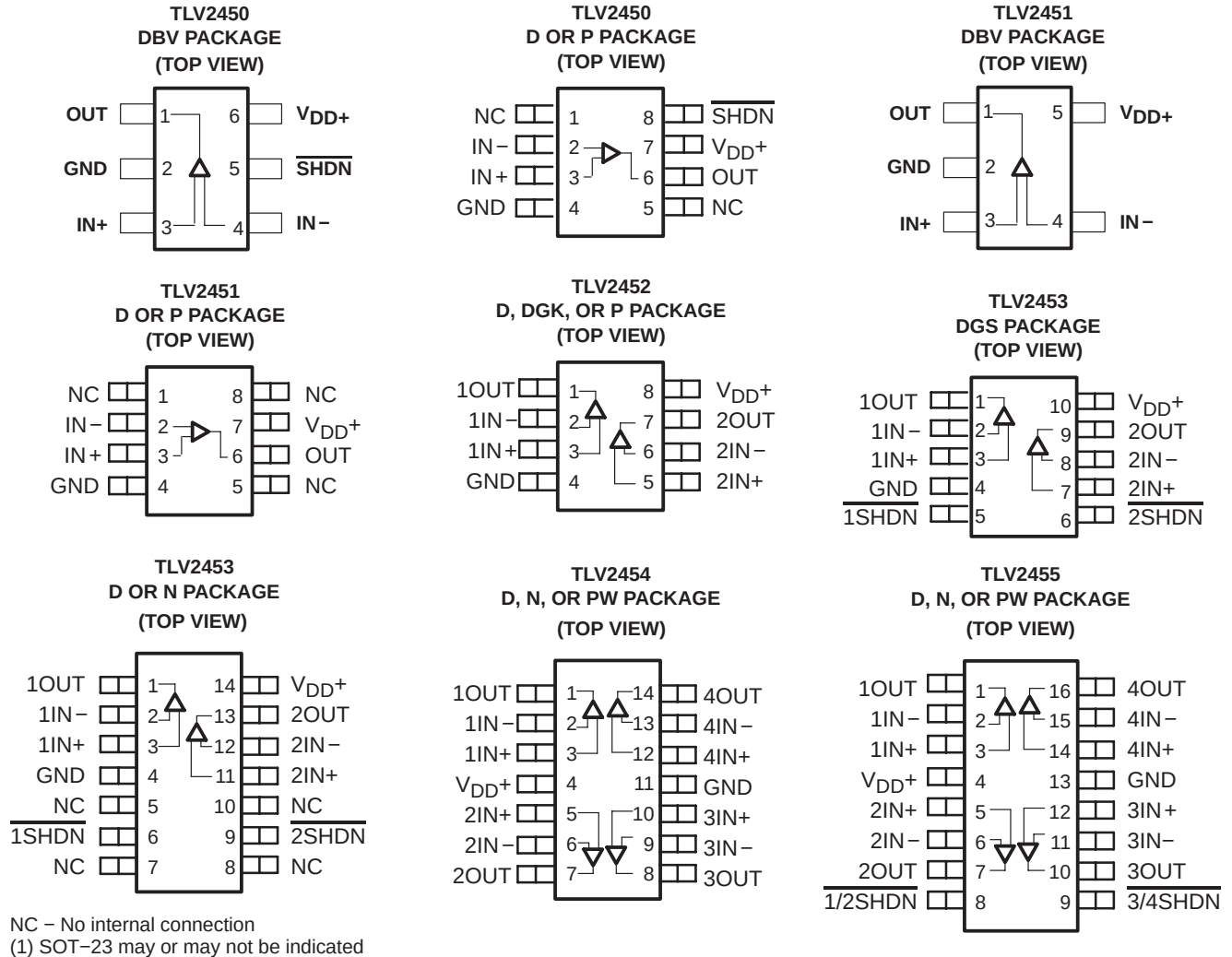
[†] This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2454CDR).

NOTE: For the most current package and ordering information, see the Package Option Addendum located at the end of this data sheet, or refer to our web site at www.ti.com.

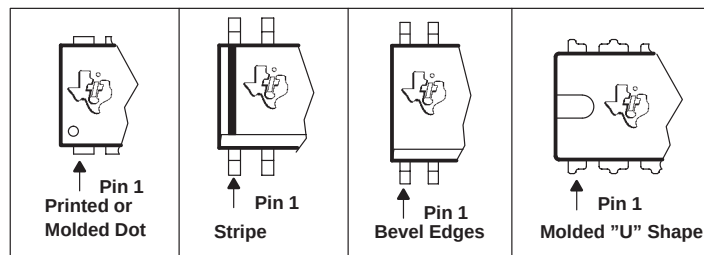
TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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TLV245x PACKAGE PINOUTS⁽¹⁾



TYPICAL PIN 1 INDICATORS



TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA

FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V_{DD} (see Note 1)	7 V
Differential input voltage, V_{ID}	$\pm V_{DD}$
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A : C suffix	0°C to 70°C
I suffix	–40°C to 125°C
Maximum junction temperature, T_J	150°C
Storage temperature range, T_{stg}	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE: All voltage values, except differential voltages, are with respect to GND.

DISSIPATION RATING TABLE

PACKAGE	θ_{JC} (°C/W)	θ_{JA} (°C/W)	$T_A \leq 25^\circ\text{C}$ POWER RATING
D (8)	38.3	176	710 mW
D (14)	26.9	122.3	1022 mW
D (16)	25.7	114.7	1090 mW
DBV (5)	55	324.1	385 mW
DBV (6)	55	294.3	425 mW
DGK (8)	54.2	259.9	481 mW
DGS (10)	54.1	257.7	485 mW
N (14, 16)	32	78	1600 mW
P (8)	41	104	1200 mW
PW (14)	29.3	173.6	720 mW
PW (16)	28.7	161.4	774 mW

recommended operating conditions

			MIN	MAX	UNIT
Supply voltage, V _{DD}	Single supply		2.7	6	V
	Split supply		±1.35	±3	
Common-mode input voltage range, V _{ICR}			0	V _{DD}	V
Operating free-air temperature, T _A	C-suffix		0	70	°C
	I-suffix		−40	125	
Shutdown on/off voltage level‡	V _{IH}		2		V
	V _{IL}	V _{DD} = 5V	0.8		
			V _{DD} = 3V	0.5	

[‡] Relative to voltage on the GND terminal of the device.



TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA
FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT
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electrical characteristics at specified free-air temperature, $V_{DD} = 3$ V (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T _A [†]	MIN	TYP	MAX	UNIT
V _{IO}	Input offset voltage	V _{DD} = ±1.5 V V _{IC} = 0, V _O = 0, R _S = 50 Ω		25°C		300	1500	μV
				Full range		2000		
	TLV245xA			25°C		300	1000	
				Full range		1300		
α _{VIO}	Temperature coefficient of input offset voltage					0.3		μV/°C
I _{IO}	Input offset current			25°C		0.3	4.5	nA
				Full range			5.5	
I _{IB}	Input bias current			25°C		0.9	5	nA
				Full range			7	
V _{OH}	High-level output voltage	V _{IC} = 1.5 V, I _{OH} = −500 μA		25°C	2.85	2.95		V
				Full range	2.83			
V _{OL}	Low-level output voltage	V _{IC} = 1.5 V, I _{OL} = 500 μA		25°C		0.09	0.16	V
				Full range			0.2	
I _{OS}	Short-circuit output current	Sourcing		25°C	4	12		mA
				Full range	3			
		Sinking		25°C	2	7		
				Full range	1			
I _O	Output current	V _O = 0.5 V from rail		25°C		±4		mA
A _{VD}	Large-signal differential voltage amplification	V _{O(PP)} = 1 V, R _L = 10 kΩ		25°C	96	110		dB
				Full range	91			
r _{i(d)}	Differential input resistance			25°C		10 ⁹		Ω
C _{IC}	Common-mode input capacitance	f = 10 kHz		25°C		4.5		pF
z ₀	Closed-loop output impedance	f = 10 kHz, A _V = 10		25°C		80		Ω
CMRR	Common-mode rejection ratio	V _{IC} = 0 to 3 V, R _S = 50 Ω		25°C	70	80		dB
			TLV245xC	Full range	66			dB
k _{SVR}	Supply voltage rejection ratio (ΔV _{DD} /ΔV _{IO})	V _{DD} = 2.7 V to 6 V, No load	V _{IC} = V _{DD} /2,	25°C	76	89		dB
				Full range	74			
		V _{DD} = 3 V to 5 V, No load	V _{IC} = V _{DD} /2,	25°C	88	106		
				Full range	84			
I _{DD}	Supply current (per channel)	V _O = 1.5 V, No load		25°C		23	35	μA
			TLV245xC	Full range			40	
			TLV245xI	Full range			45	
I _{DD(SHDN)}	Supply current in shutdown mode (TLV2450, TLV2453, TLV2455) (per channel)	SHDN = −V _{DD}		25°C		12	65	nA
			TLV245xC	Full range			70	
			TLV245xI	Full range			80	

† Full range is 0°C to 70°C for C suffix and -40°C to 125°C for I suffix.



TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA
FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT
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operating characteristics at specified free-air temperature, $V_{DD} = 3\text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T _A [†]	MIN	TYP	MAX	UNIT
SR	Slew rate at unity gain	V _{O(PP)} = 0.8 V, R _L = 10 kΩ		25°C	0.05	0.11		V/μs
				Full range	0.02			
V _n	Equivalent input noise voltage	f = 100 Hz		25°C		49		nV/√Hz
		f = 1 kHz		25°C		51		
I _n	Equivalent input noise current	f = 1 kHz		25°C		3.5		pA/√Hz
THD + N	Total harmonic distortion plus noise	V _{O(PP)} = 1.5 V, R _L = 10 kΩ, f = 1 kHz	A _V = 1	25°C		0.04%		
			A _V = 10			0.3%		
			A _V = 100			1.5%		
t _(on)	Amplifier turnon time	A _V = 5, R _L = OPEN, Measured at 50% point		25°C		59		μs
t _(off)	Amplifier turnoff time			25°C		836		ns
Gain-bandwidth product		f = 10 kHz,	R _L = 10 kΩ	25°C		200		kHz
t _s	Settling time	V _{(STEP)PP} = 2 V, A _V = -1, C _L = 10 pF, R _L = 10 kΩ	0.1%	25°C		26		μs
			0.01%			31		
		V _{(STEP)PP} = 2 V, A _V = -1, C _L = 56 pF, R _L = 10 kΩ	0.1%			26		
			0.01%			31		
φ _m	Phase margin	R _L = 10 kΩ,	C _L = 1000 pF	25°C		56°		
Gain margin		R _L = 10 kΩ,	C _L = 1000 pF	25°C		7		dB

† Full range is 0°C to 70°C for C suffix and -40°C to 125°C for I suffix.

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA
FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT
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electrical characteristics at specified free-air temperature, $V_{DD} = 5$ V (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T _A [†]	MIN	TYP	MAX	UNIT	
V _{IO}	Input offset voltage	TLV245x		25°C		300	1500	μV	
				Full range			2000		
				TLV245xA	25°C		300		1000
					Full range				1300
α _{VIO}	Temperature coefficient of input offset voltage	V _{DD} = ±2.5 V V _{IC} = 0,	V _O = 0, R _S = 50 Ω			0.3		μV/°C	
I _{IO}	Input offset current			25°C		0.3	4.5	nA	
I _{IB}	Input bias current			Full range			5.5		
				25°C		0.5	5	nA	
V _{OH}	High-level output voltage	V _{IC} = 2.5 V,	I _{OH} = -500 μA	25°C	4.87	4.97			V
				Full range	4.85				
V _{OL}	Low-level output voltage	V _{IC} = 2.5 V,	I _{OL} = 500 μA	25°C		0.07	0.15	V	
				Full range			0.16		
I _{OS}	Short-circuit output current	Sourcing		25°C	20	32		mA	
				Full range	18				
		Sinking		25°C	12	18			
				Full range	10				
I _O	Output current	V _O = 0.5 V from rail		25°C		±10		mA	
A _{VD}	Large-signal differential voltage amplification	V _{O(PP)} = 3 V,	R _L = 10 kΩ	25°C	96	103		dB	
				Full range	91				
r _{i(d)}	Differential input resistance			25°C		10 ⁹		Ω	
C _{IC}	Common-mode input capacitance	f = 10 kHz		25°C		4.5		pF	
z _O	Closed-loop output impedance	f = 10 kHz, A _V = 10		25°C		45		Ω	
CMRR	Common-mode rejection ratio	V _{IC} = 0 to 5 V, R _S = 50 Ω	TLV245xC	25°C	70	80		dB	
				Full range	68				
k _{SVR}	Supply voltage rejection ratio (ΔV _{DD} /ΔV _{IO})	V _{DD} = 2.7 V to 6 V, No load	V _{IC} = V _{DD} /2,	25°C	76	89		dB	
				Full range	74				
		V _{DD} = 3 V to 5 V, No load		25°C	88	106			
				Full range	84				
I _{DD}	Supply current (per channel)	V _O = 2.5 V, No load	TLV245xC	25°C		23	42	μA	
				Full range			44		
				TLV245xI	Full range				46
I _{DD(SHDN)}	Supply current in shutdown mode (TLV2450, TLV2453, TLV2455) (per channel)	SHDN = -V _{DD}	TLV245xC	25°C		16	70	nA	
				Full range			70		
				TLV245xI	Full range				80

† Full range is 0°C to 70°C for C suffix and –40°C to 125°C for I suffix.



TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA
FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT
OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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operating characteristics at specified free-air temperature, $V_{DD} = 5$ V (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T _A [†]	MIN	TYP	MAX	UNIT
SR	Slew rate at unity gain	V _{O(PP)} = 2 V, R _L = 10 kΩ		25°C	0.05	0.11		V/μs
				Full range	0.02			
V _n	Equivalent input noise voltage	f = 100 Hz		25°C		49		nV/√Hz
		f = 1 kHz		25°C		52		
I _n	Equivalent input noise current	f = 1 kHz		25°C		3.5		pA/√Hz
THD + N	Total harmonic distortion plus noise	V _{O(PP)} = 3 V, R _L = 10 kΩ, f = 1 kHz	A _V = 1	25°C		0.02%		
			A _V = 10			0.18%		
			A _V = 100			0.9%		
t _(on)	Amplifier turnon time	A _V = 5, R _L = OPEN,		25°C		59		μs
t _(off)	Amplifier turnoff time	Measured at 50% point		25°C		836		ns
Gain-bandwidth product		f = 10 kHz, R _L = 10 kΩ		25°C		220		kHz
t _s	Settling time	V _{(STEP)PP} = 2 V, A _V = -1, C _L = 10 pF, R _L = 10 kΩ	0.1%	25°C		24		μs
			0.01%			30		
		V _{(STEP)PP} = 2 V, A _V = -1, C _L = 56 pF, R _L = 10 kΩ	0.1%			25		
			0.01%			30		
φ _m	Phase margin	R _L = 10 kΩ,	C _L = 1000 pF	25°C		56°		
Gain margin		R _L = 10 kΩ,	C _L = 1000 pF	25°C		7		dB

† Full range is 0°C to 70°C for C suffix and -40°C to 125°C for I suffix.

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TYPICAL CHARACTERISTICS

Table of Graphs

			FIGURE
V_{IO}	Input offset voltage	vs Common-mode input voltage	1, 2
I_{IO}	Input offset current	vs Common-mode input voltage vs Free-air temperature	3, 4 7, 8
I_{IB}	Input bias current	vs Common-mode input voltage vs Free-air temperature	5, 6 7, 8
A_{VD}	Differential voltage amplification	vs Frequency	9, 10
	Phase	vs Frequency	9, 10
V_{OL}	Low-level output voltage	vs Low-level output current	11, 13
V_{OH}	High-level output voltage	vs High-level output current	12, 14
Z_o	Output impedance	vs Frequency	15, 16
CMRR	Common-mode rejection ratio	vs Frequency	17
PSRR	Power supply rejection ratio	vs Frequency	18
I_{DD}	Supply current	vs Supply voltage	19
I_{DD}	Supply current	vs Free-air temperature	20
V_n	Equivalent input noise voltage	vs Frequency	21
THD + N	Total harmonic distortion plus noise	vs Frequency	22, 23
ϕ_m	Phase margin	vs Load capacitance	24
	Gain-bandwidth product	vs Supply voltage	25
SR	Slew rate	vs Supply voltage vs Free-air temperature	26 27
$V_{O(PP)}$	Maximum peak-to-peak output voltage	vs Frequency	28
	Crosstalk	vs Frequency	29, 30
	Small-signal follower pulse response	vs Time	31, 33
	Large-signal follower pulse response	vs Time	32, 34
	Shutdown on supply current	vs Time	35
	Shutdown off supply current	vs Time	36
	Shutdown supply current	vs Free-air temperature	37
	Shutdown supply current	vs Time	38 – 41
	Shutdown pulse	vs Time	38 – 41
	Shutdown off pulse response	vs Time	42, 43
	Shutdown on pulse response	vs Time	44, 45
	Shutdown reverse isolation	vs Frequency	46
	Shutdown forward isolation	vs Frequency	47



TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA

FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT

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TYPICAL CHARACTERISTICS

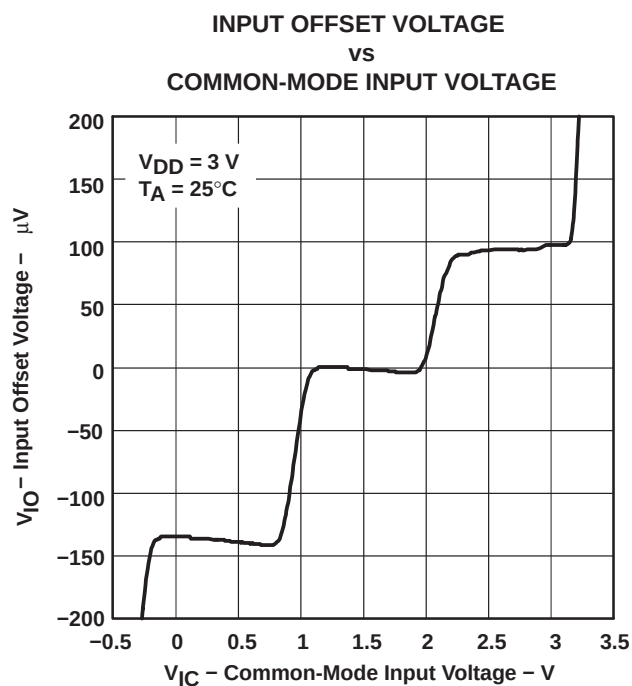


Figure 1

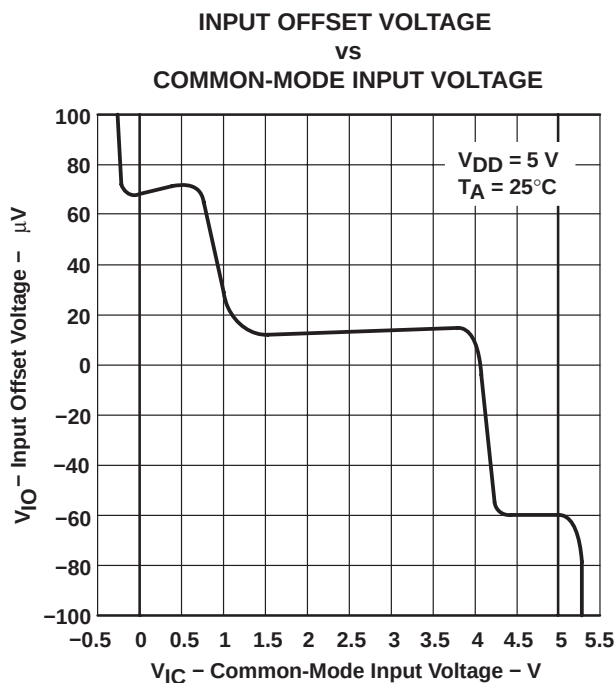


Figure 2

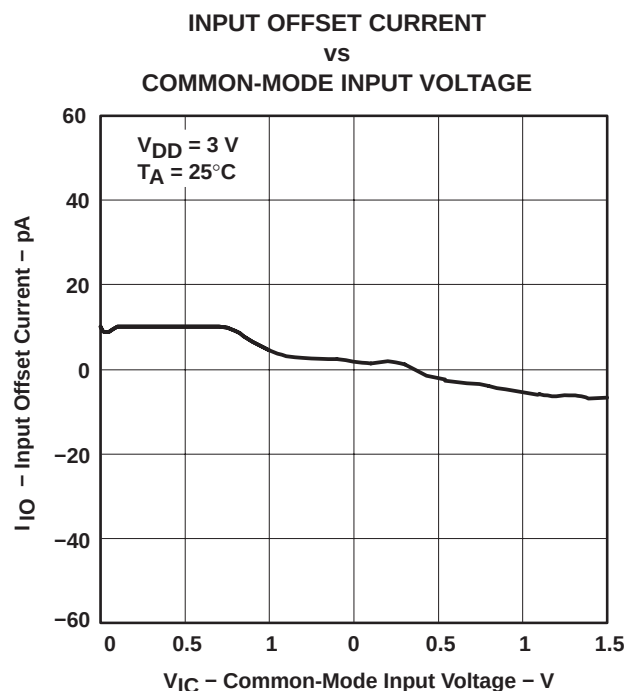


Figure 3

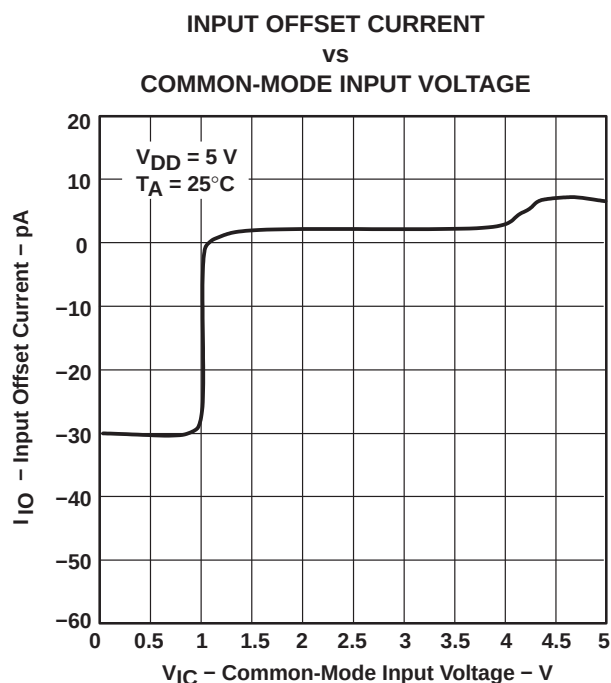


Figure 4

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA
FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT
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TYPICAL CHARACTERISTICS

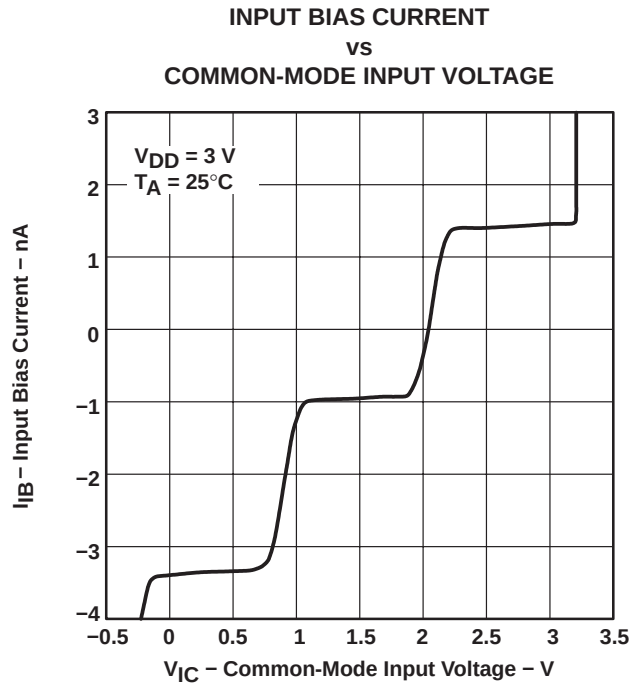


Figure 5

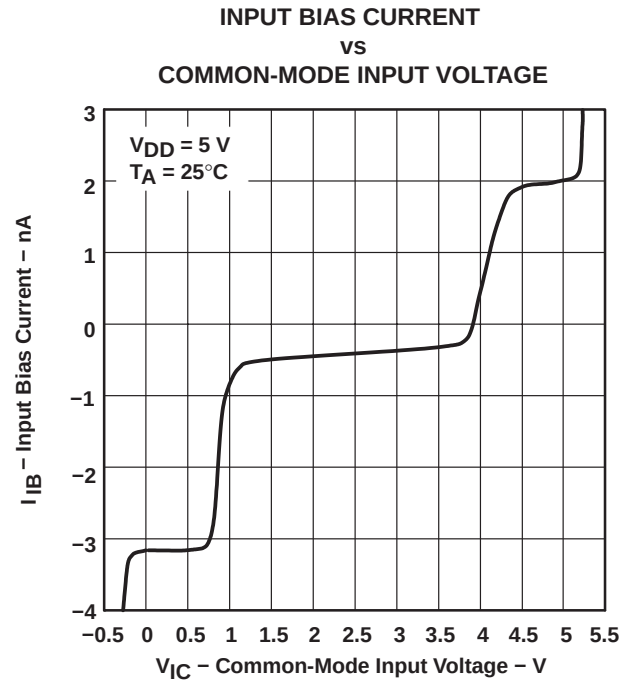


Figure 6

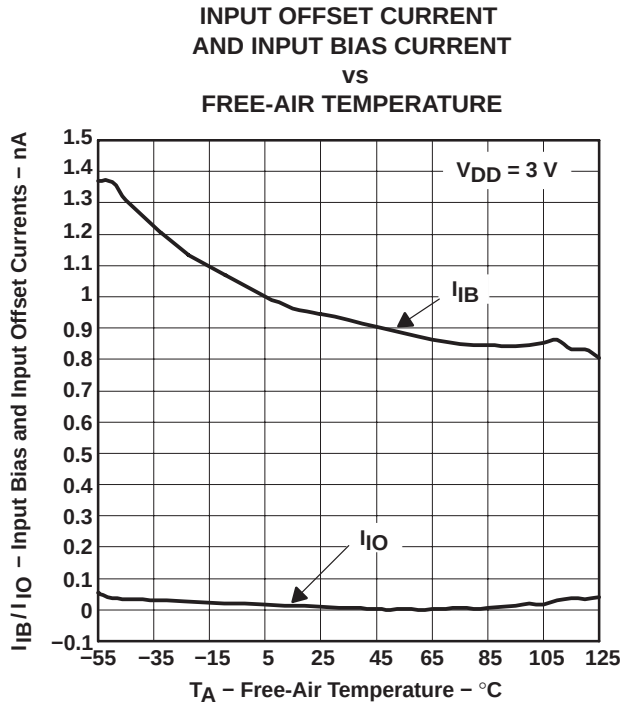


Figure 7

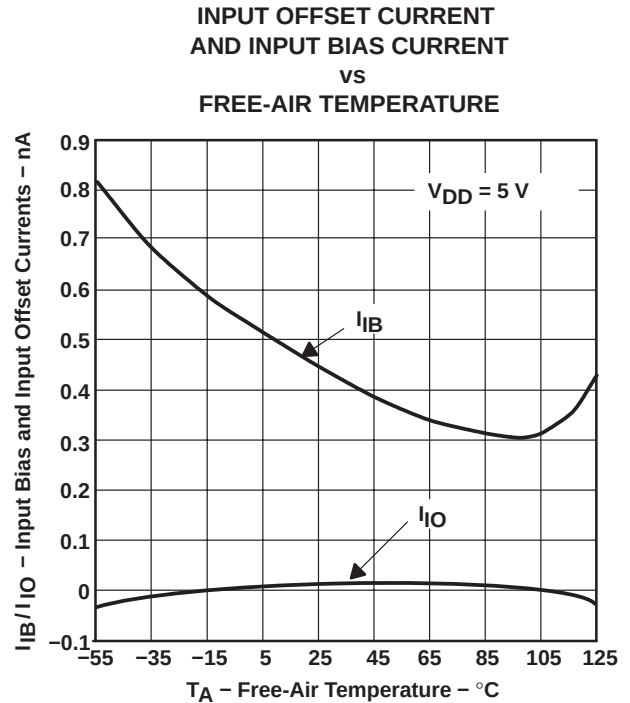


Figure 8

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA

FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT

OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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TYPICAL CHARACTERISTICS

DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE vs FREQUENCY

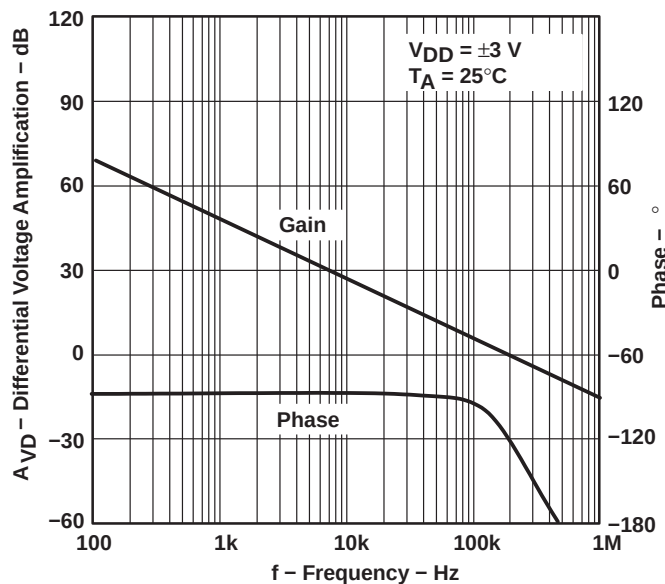


Figure 9

DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE vs FREQUENCY

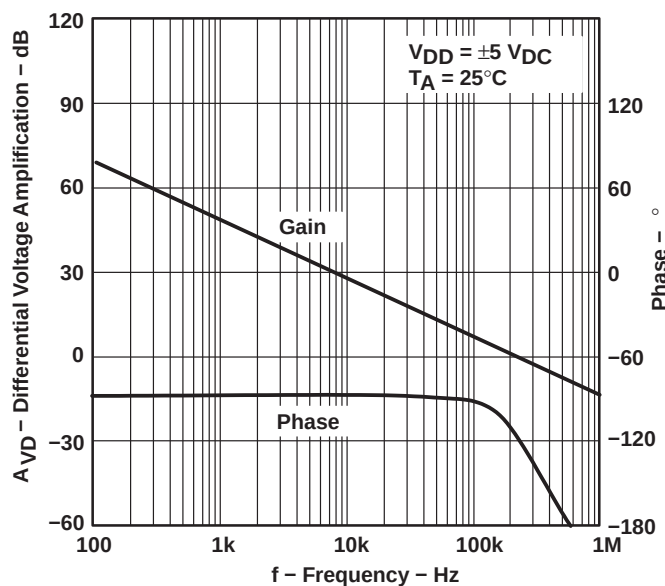


Figure 10

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA
FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT
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TYPICAL CHARACTERISTICS

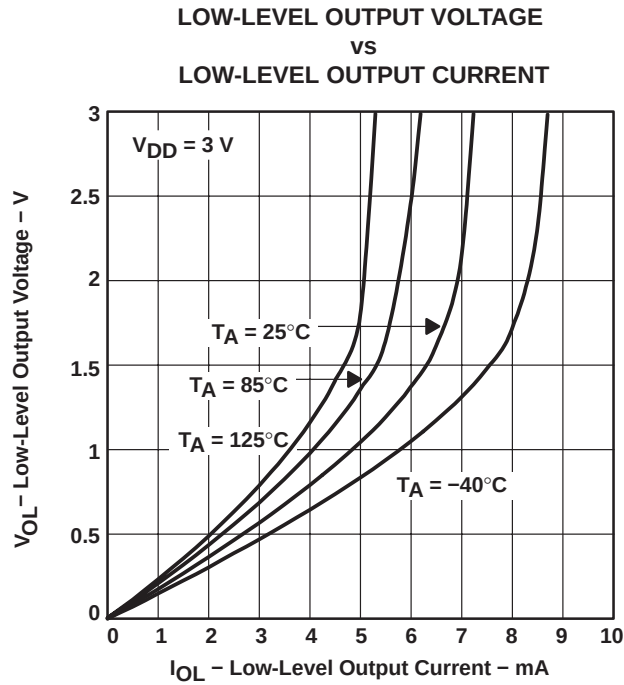


Figure 11

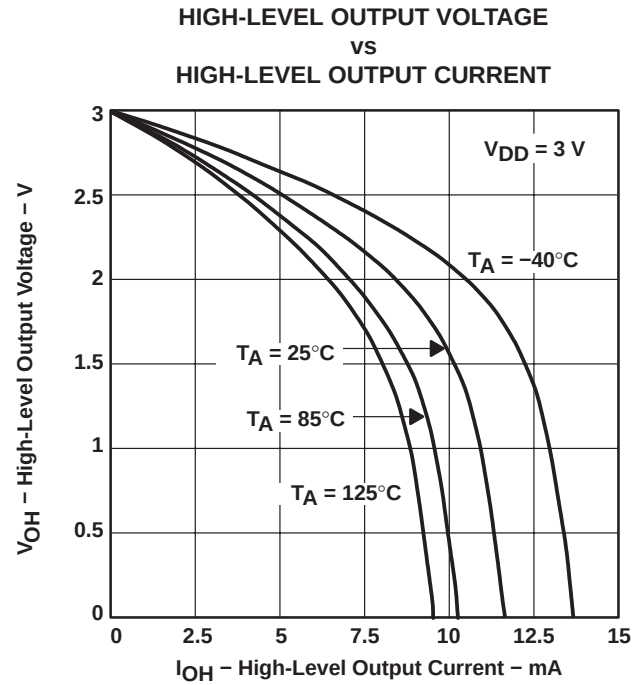


Figure 12

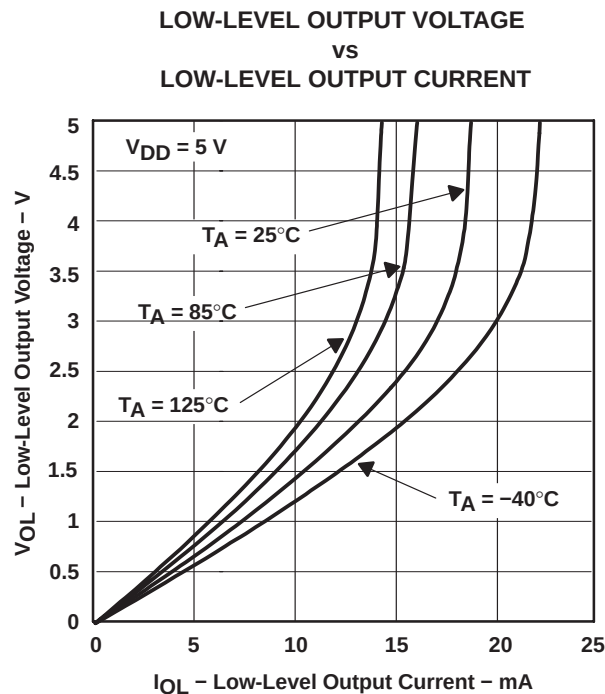


Figure 13

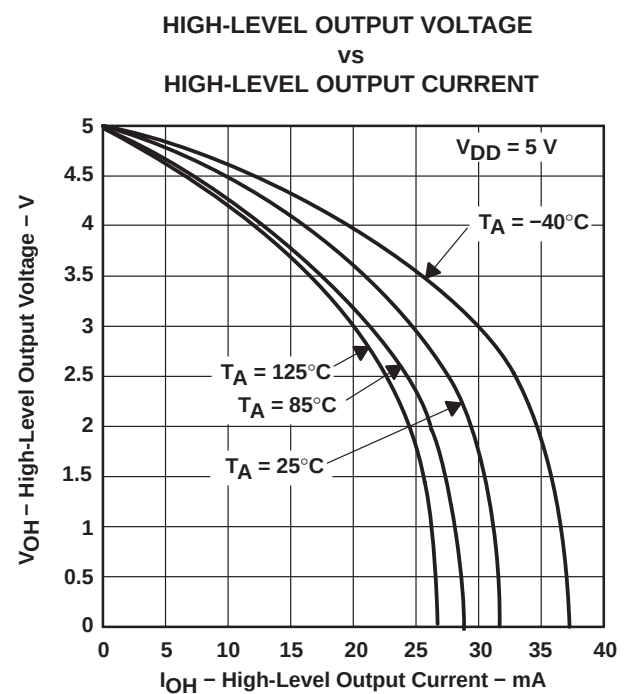


Figure 14

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA
FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT
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TYPICAL CHARACTERISTICS

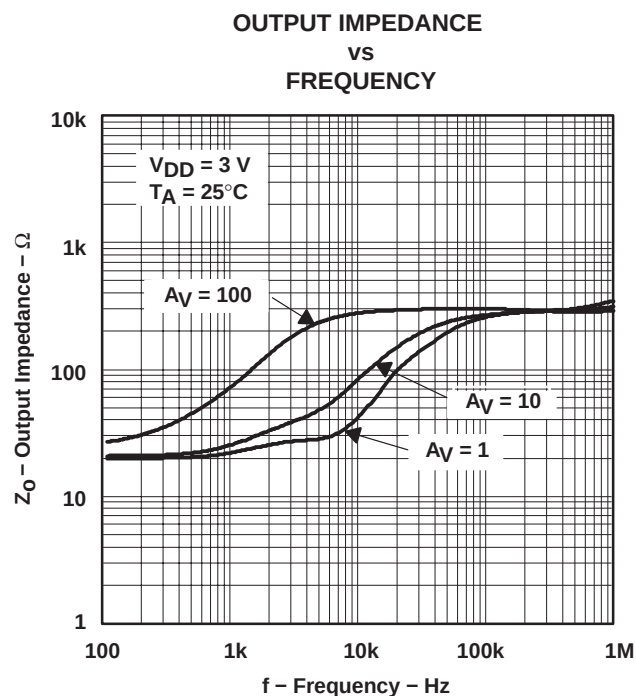


Figure 15

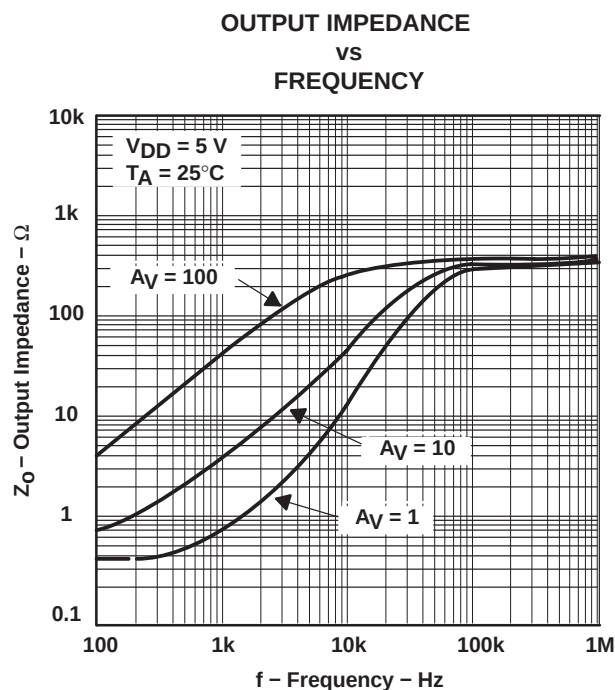


Figure 16

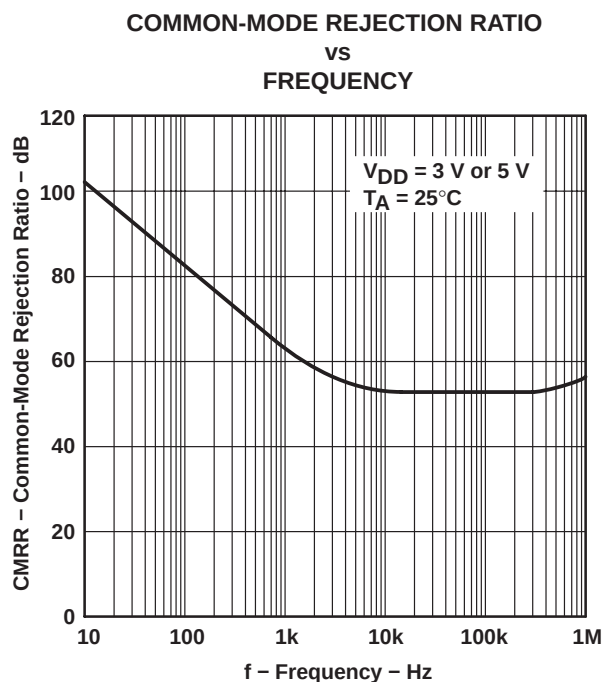


Figure 17

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA
FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT
OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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TYPICAL CHARACTERISTICS

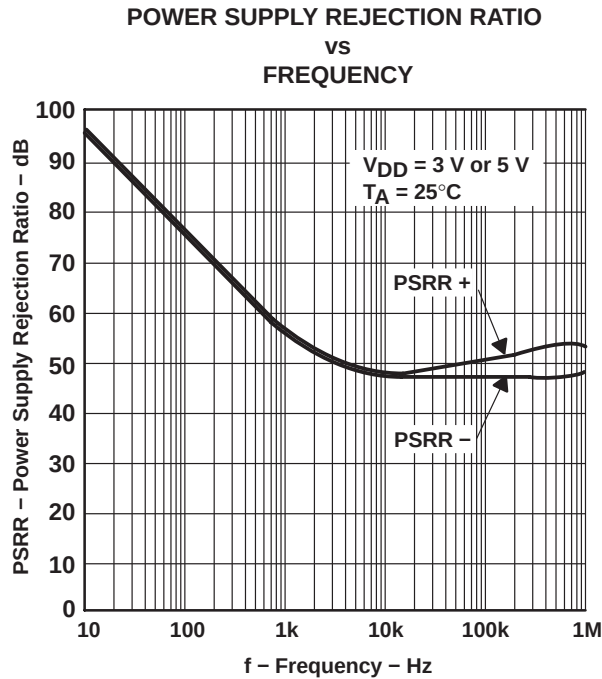


Figure 18

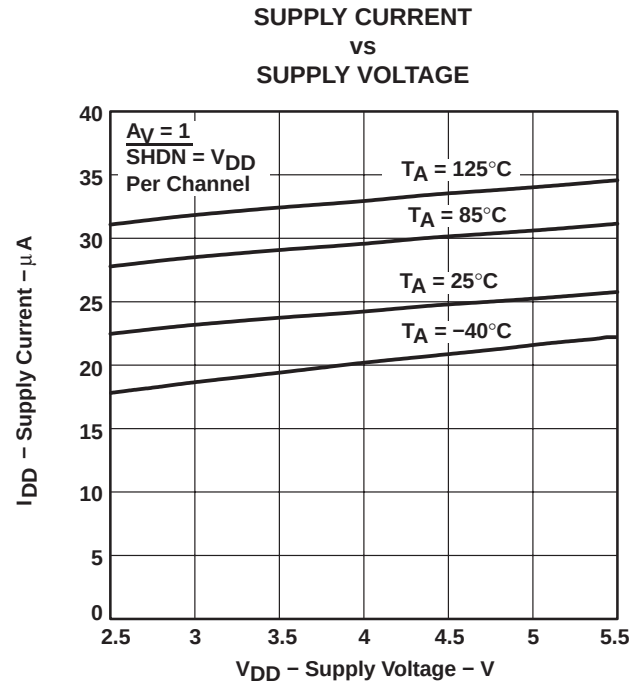


Figure 19

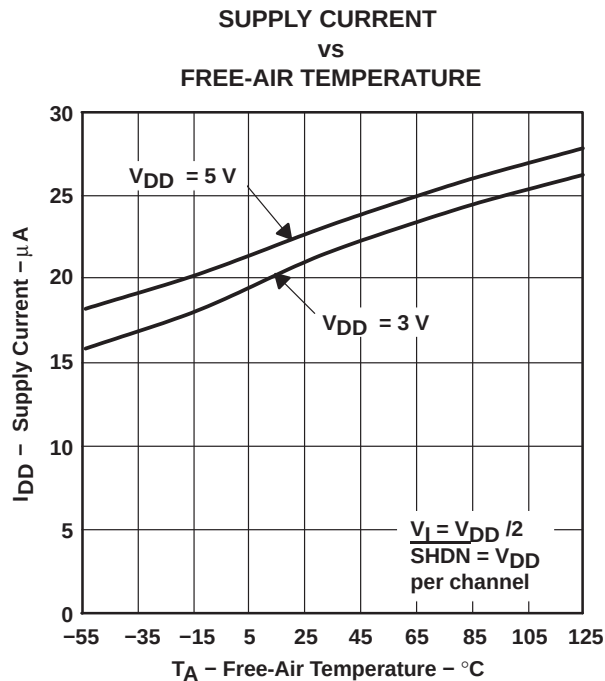


Figure 20

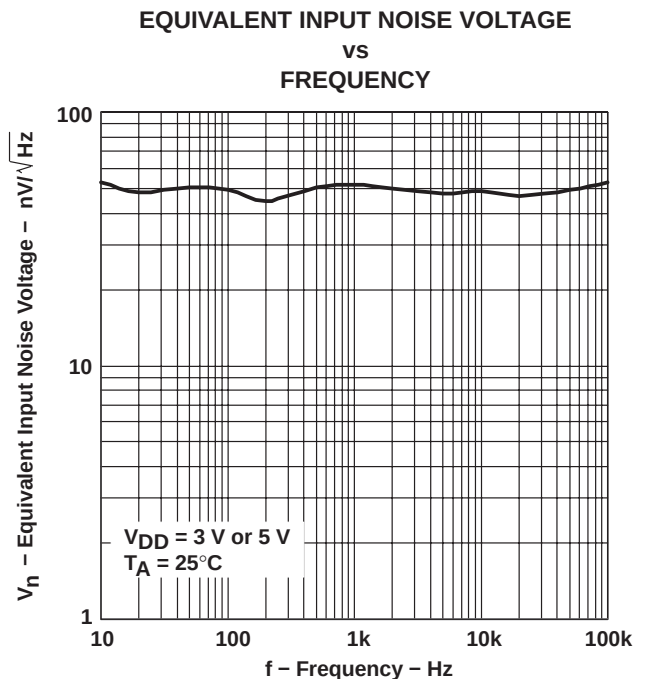


Figure 21

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA

FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT

OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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TYPICAL CHARACTERISTICS

**TOTAL HARMONIC DISTORTION PLUS NOISE
VS
FREQUENCY**

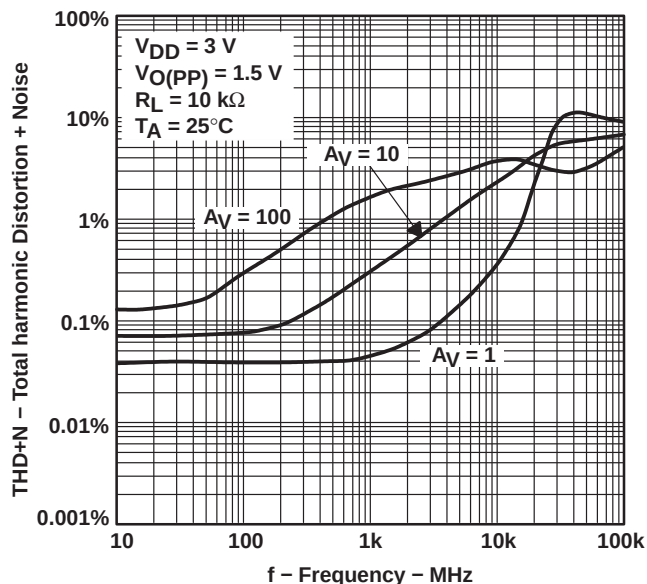


Figure 22

**TOTAL HARMONIC DISTORTION PLUS NOISE
VS
FREQUENCY**

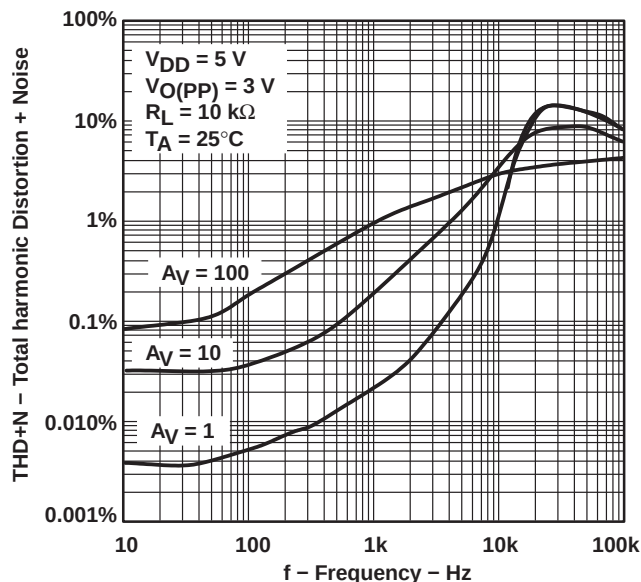


Figure 23

**PHASE MARGIN
VS
LOAD CAPACITANCE**

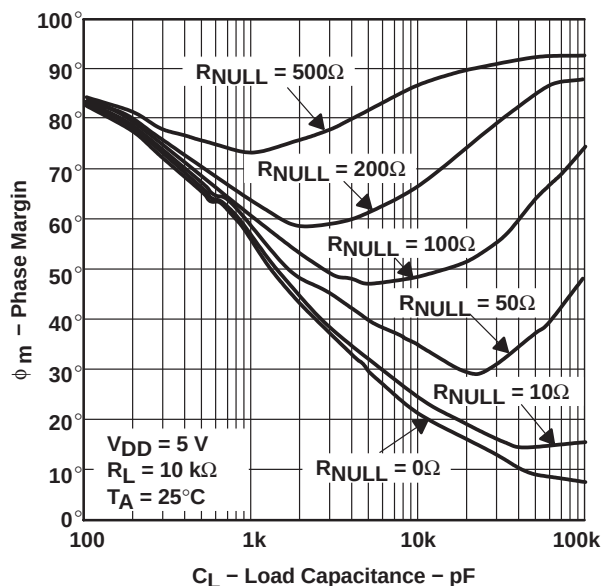


Figure 24

**GAIN-BANDWIDTH PRODUCT
VS
SUPPLY VOLTAGE**

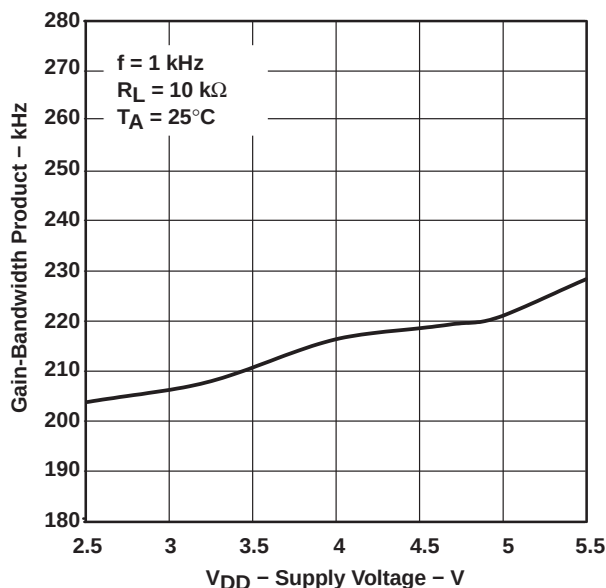


Figure 25

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA
FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT
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TYPICAL CHARACTERISTICS

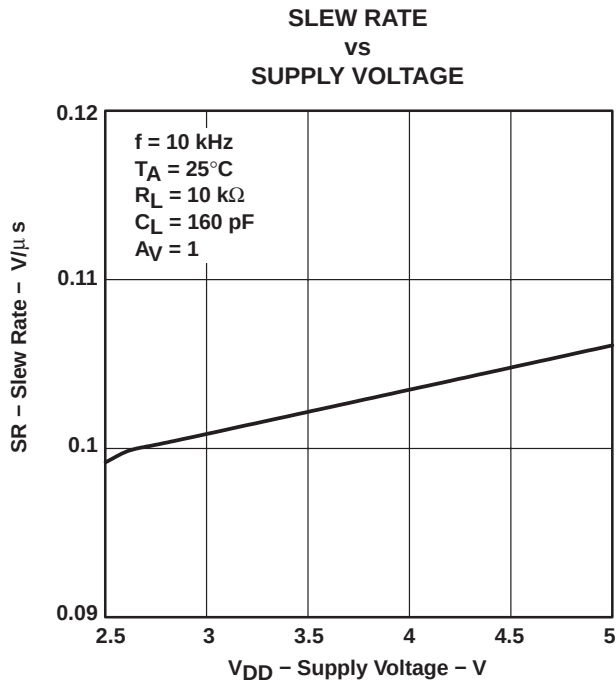


Figure 26

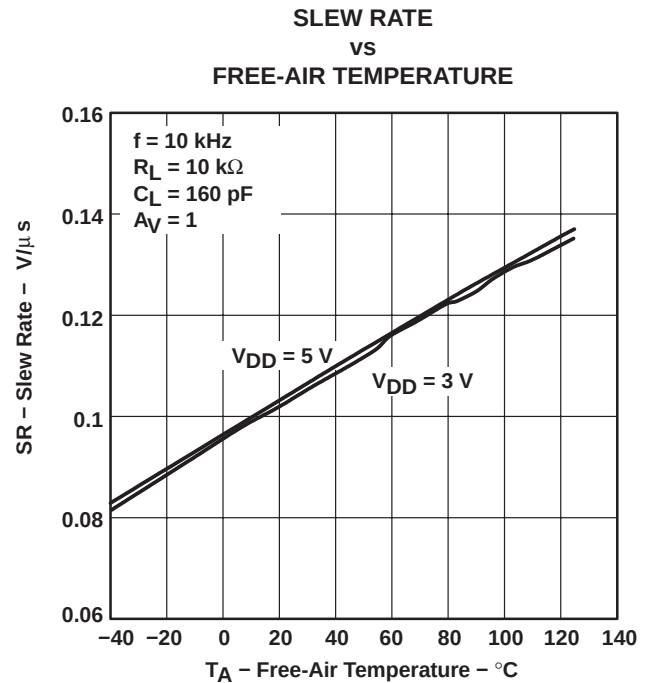


Figure 27

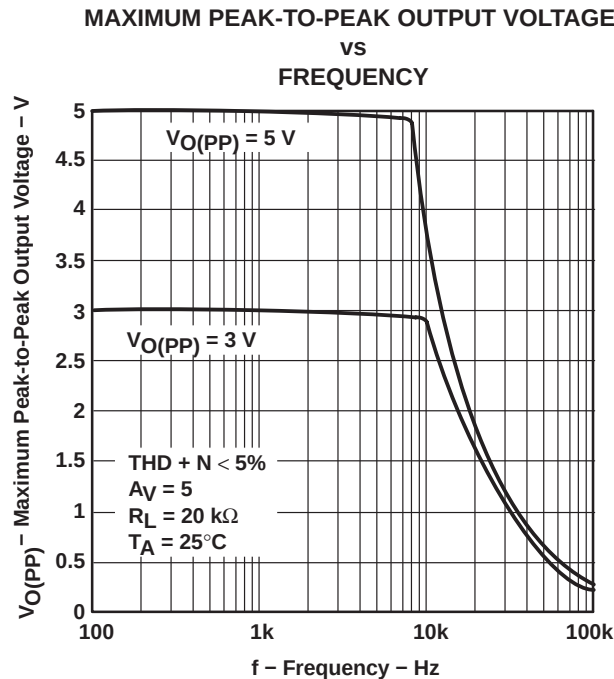


Figure 28

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA

FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT

OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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TYPICAL CHARACTERISTICS

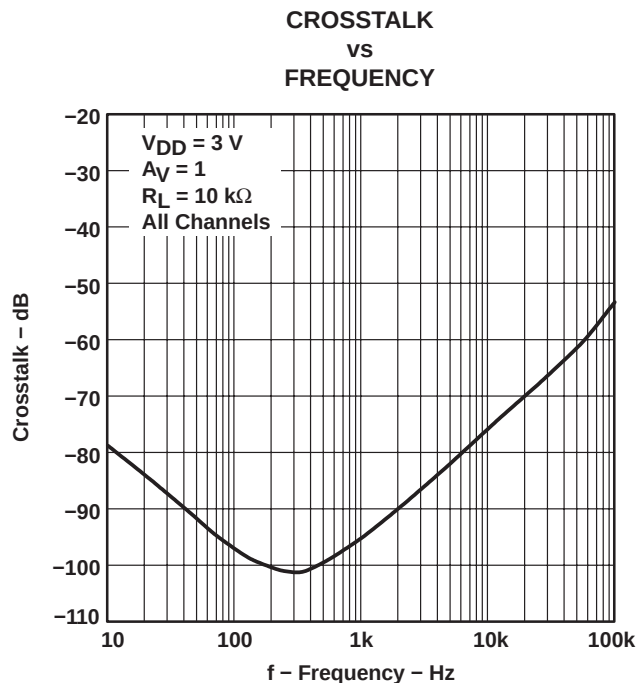


Figure 29

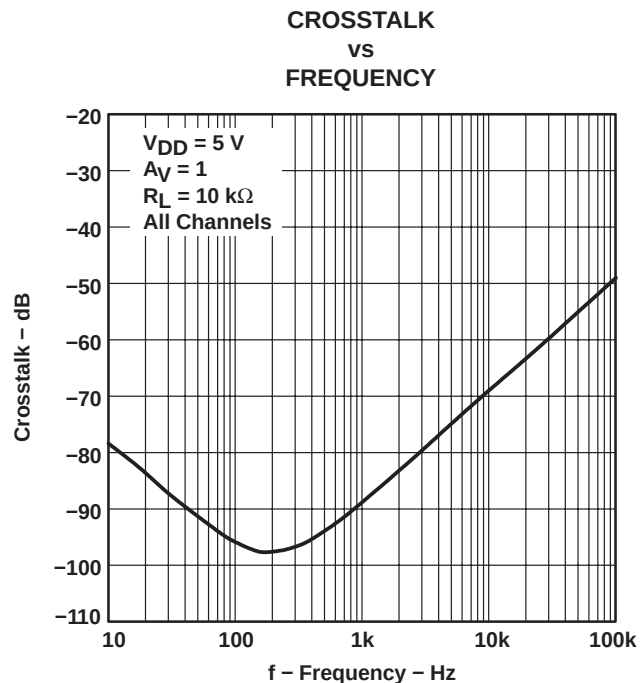


Figure 30

SMALL-SIGNAL FOLLOWER PULSE RESPONSE

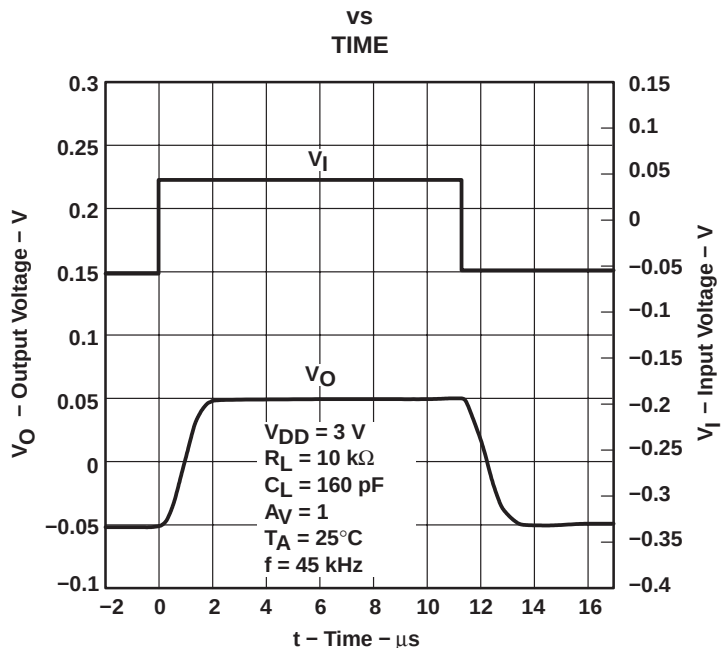


Figure 31

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA
FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT
OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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TYPICAL CHARACTERISTICS

LARGE-SIGNAL FOLLOWER PULSE RESPONSE

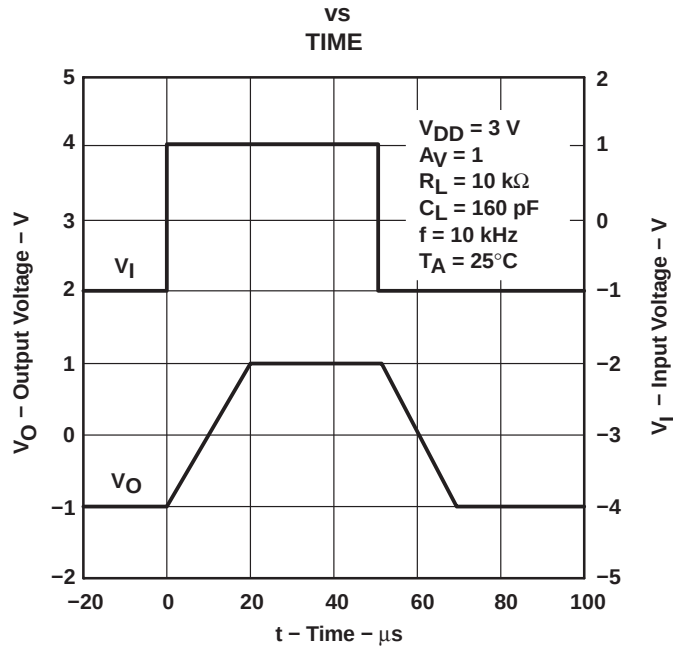


Figure 32

SMALL-SIGNAL FOLLOWER PULSE RESPONSE

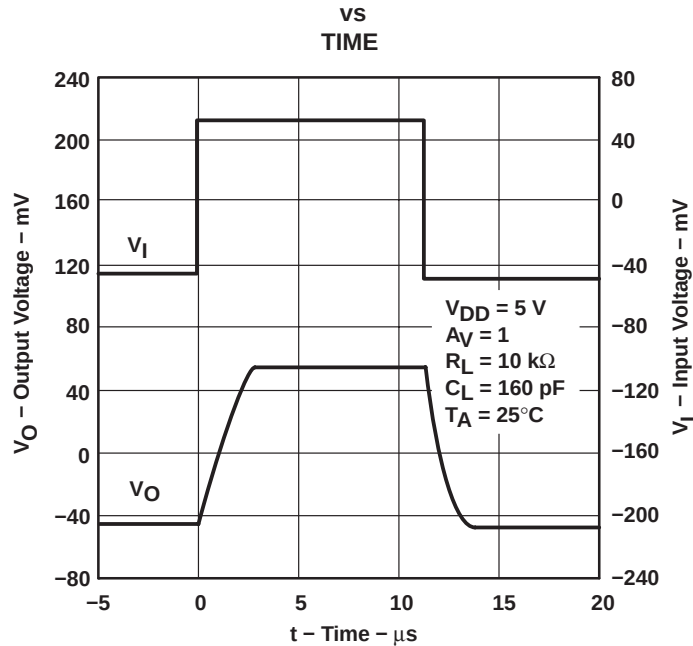


Figure 33

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA

FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT

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TYPICAL CHARACTERISTICS

LARGE-SIGNAL FOLLOWER PULSE RESPONSE

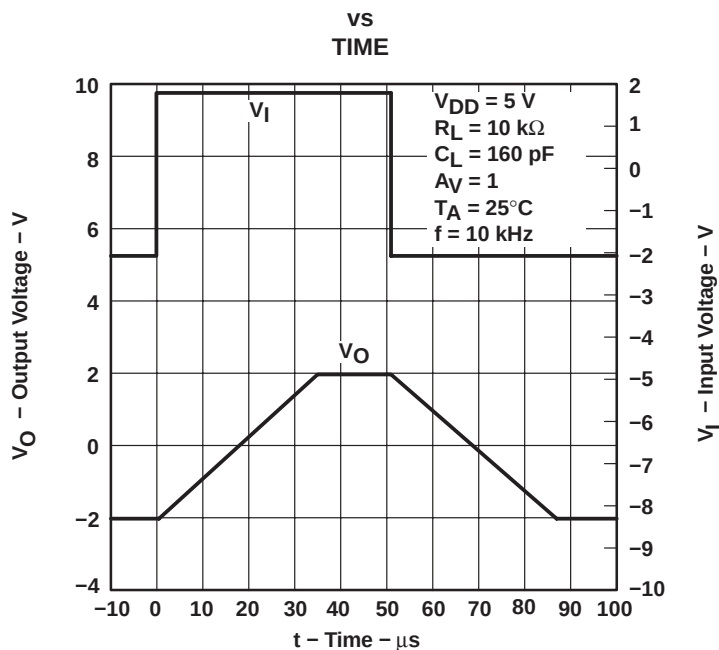


Figure 34

SHUTDOWN ON SUPPLY CURRENT

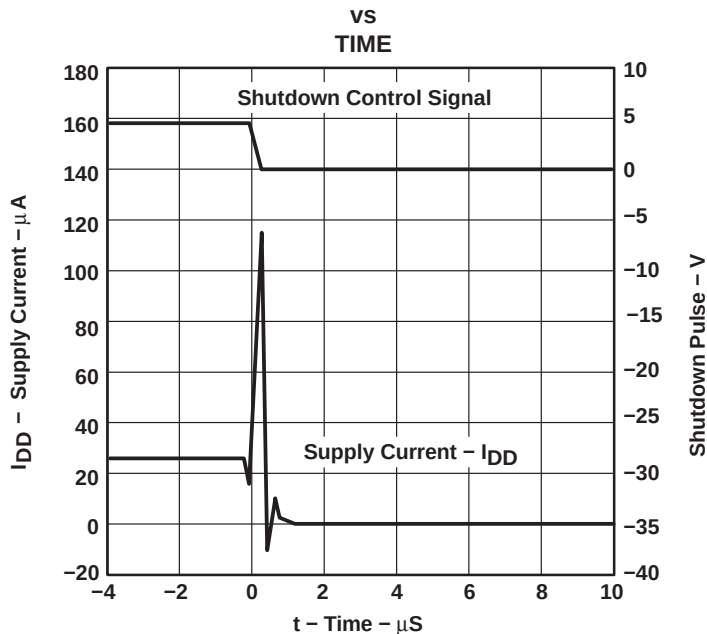


Figure 35

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA
FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT
OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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TYPICAL CHARACTERISTICS

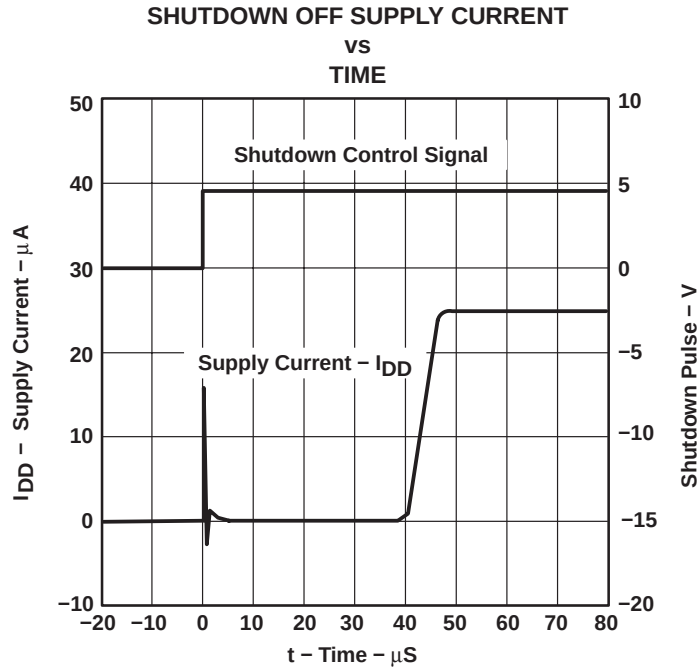


Figure 36

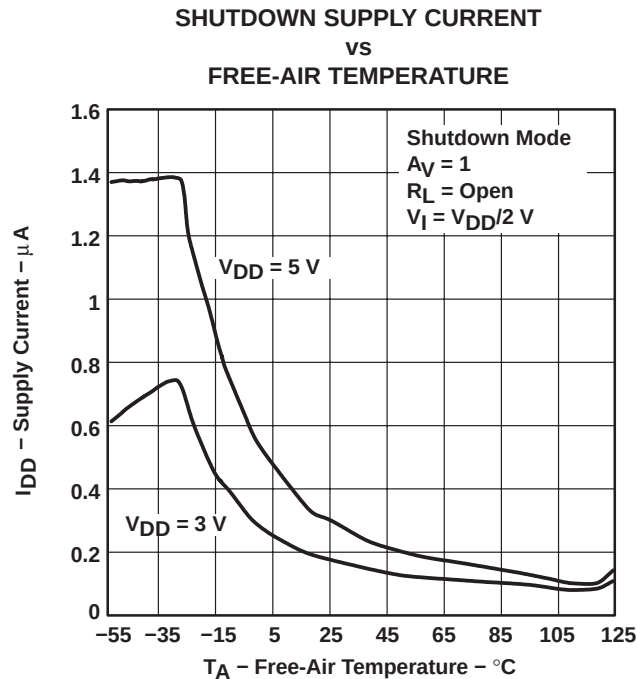


Figure 37



TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA

FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT

OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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TYPICAL CHARACTERISTICS

SHUTDOWN SUPPLY CURRENT AND SHUTDOWN PULSE vs TIME

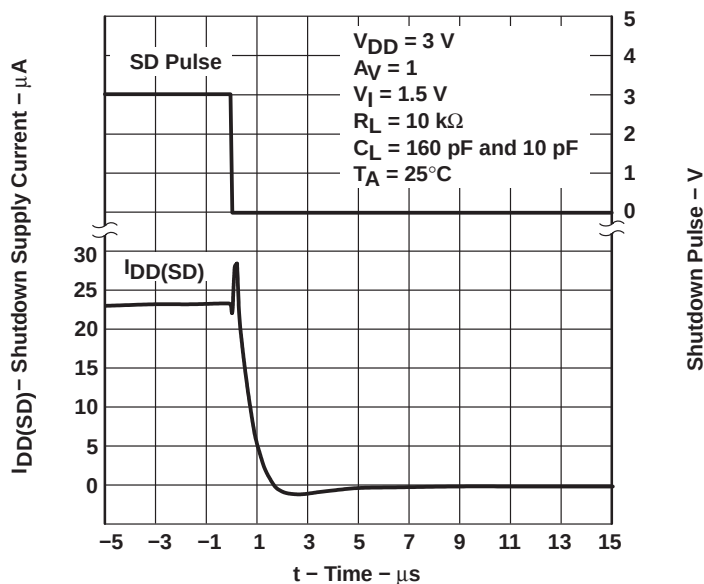


Figure 38

SHUTDOWN SUPPLY CURRENT AND SHUTDOWN PULSE vs TIME

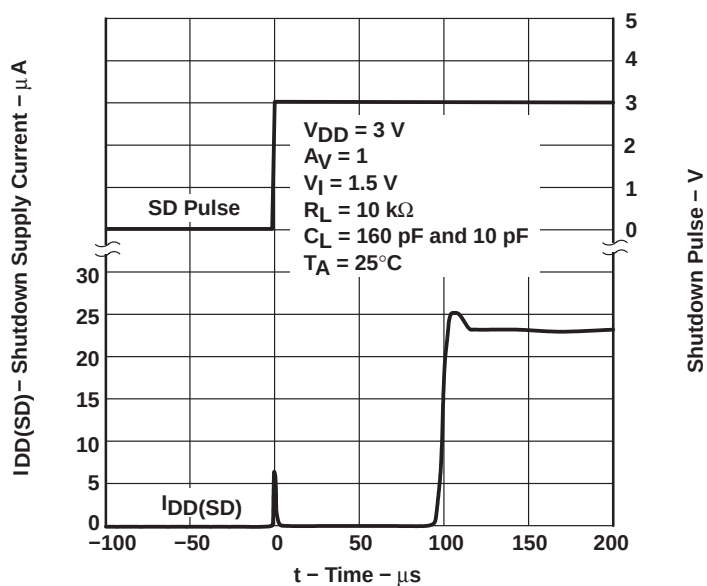


Figure 39

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA
FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT
OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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TYPICAL CHARACTERISTICS

SHUTDOWN SUPPLY CURRENT AND SHUTDOWN PULSE
vs
TIME

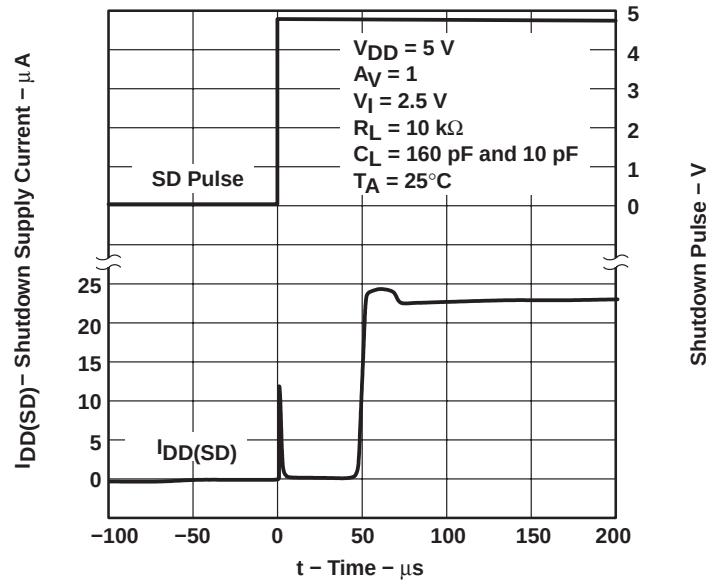


Figure 40

SHUTDOWN SUPPLY CURRENT AND SHUTDOWN PULSE
vs
TIME

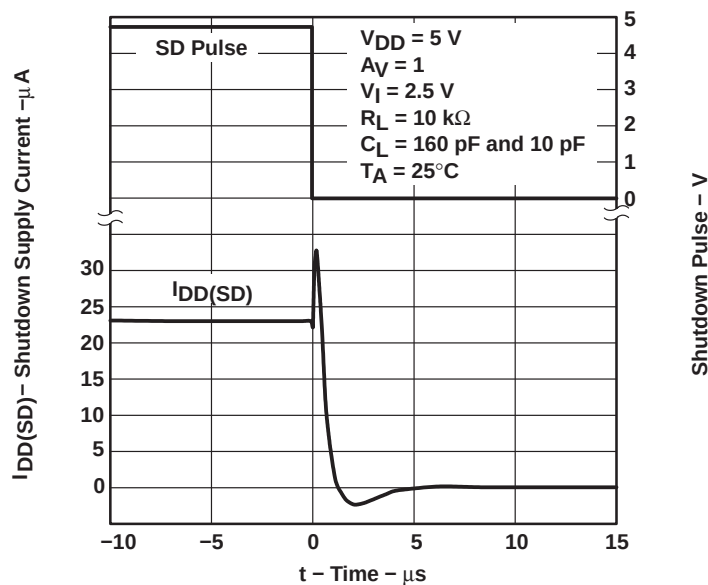


Figure 41



TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA

FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT

OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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TYPICAL CHARACTERISTICS

SHUTDOWN OFF PULSE RESPONSE

VS
TIME

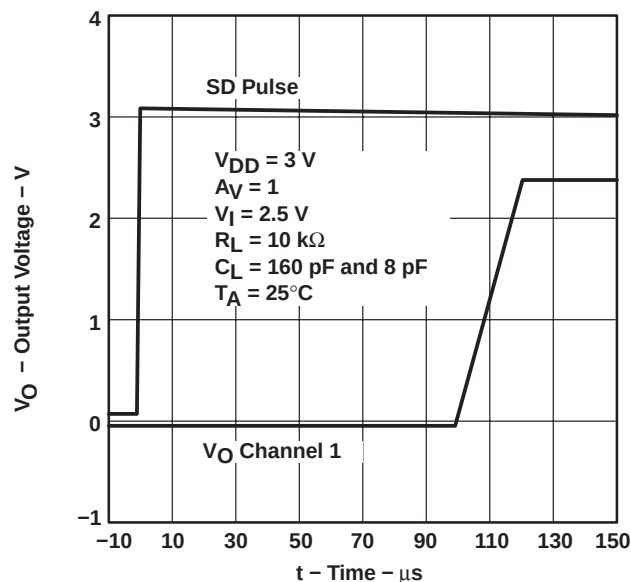


Figure 42

SHUTDOWN OFF PULSE RESPONSE

VS
TIME

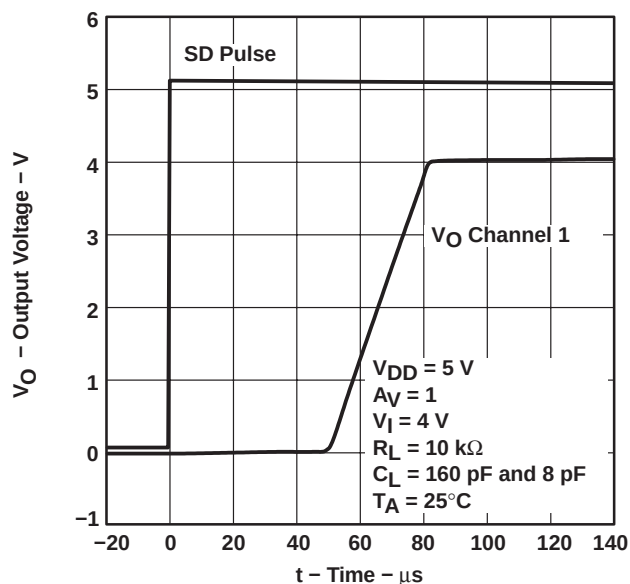


Figure 43

SHUTDOWN ON PULSE RESPONSE

VS
TIME

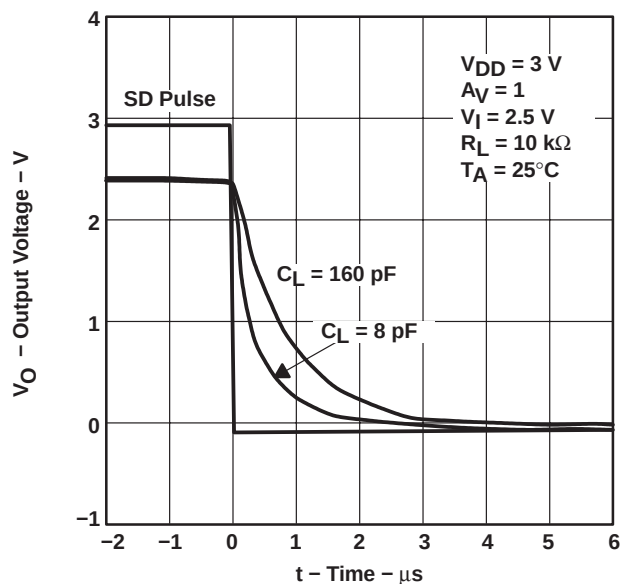


Figure 44

SHUTDOWN ON PULSE RESPONSE

VS
TIME

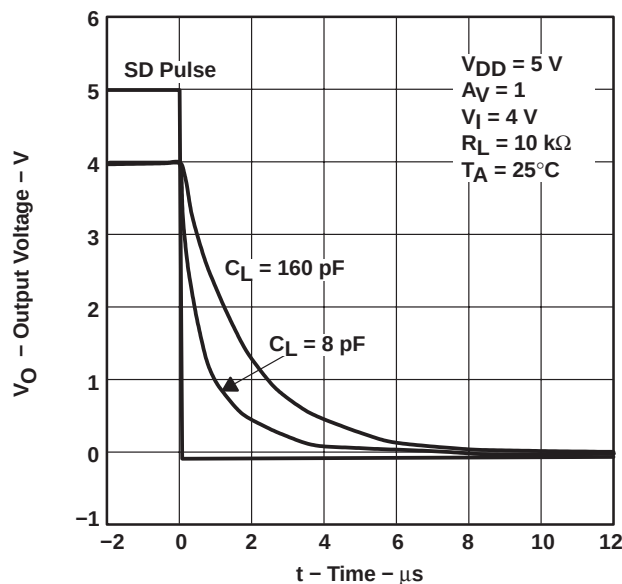


Figure 45

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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TYPICAL CHARACTERISTICS

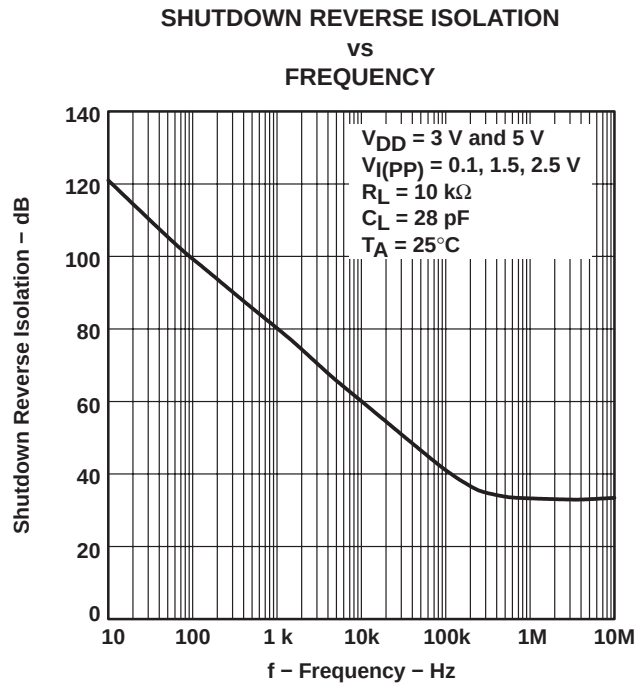


Figure 46

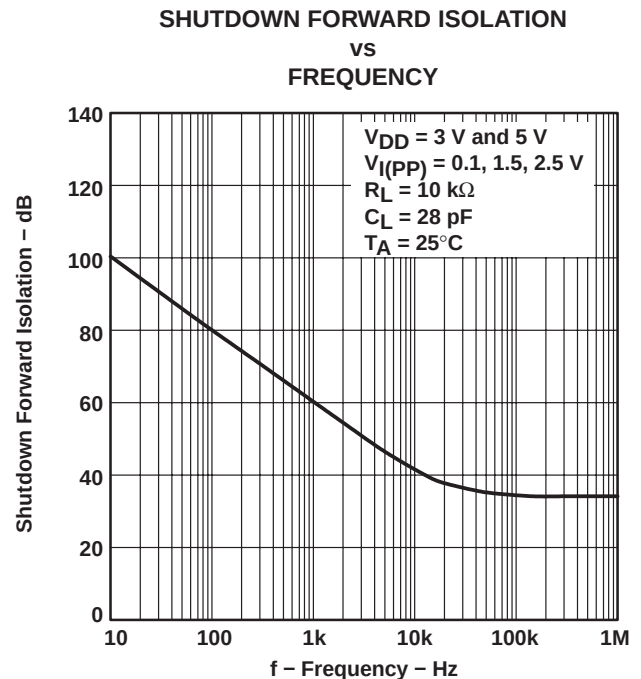


Figure 47

PARAMETER MEASUREMENT INFORMATION

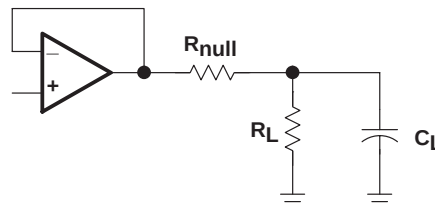


Figure 48

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA

FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT

OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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APPLICATION INFORMATION

shutdown function

Three members of the TLV245x family (TLV2450/3/5) have a shutdown terminal for conserving battery life in portable applications. When the shutdown terminal is pulled to the voltage level on the GND terminal of the device, the supply current is reduced to 16 nA/channel, the amplifier is disabled, and the outputs are placed in a high impedance mode. To enable the amplifier, the shutdown terminal must be pulled high. The shutdown terminal should never be left floating. The shutdown terminal threshold is always referenced to the GND terminal of the device. Therefore, when operating the device with split supply voltages (e.g. ± 2.5 V), the shutdown terminal needs to be pulled to V_{DD-} (not system ground) to disable the operational amplifier.

The amplifier's output with a shutdown pulse is shown in Figures 42, 43, 44, and 45. The amplifier is powered with a single 5-V supply and configured as a noninverting configuration with a gain of 5. The amplifier turnon and turnoff times are measured from the 50% point of the shutdown pulse to the 50% point of the output waveform. The times for the single, dual, and quad are listed in the data tables.

Figures 46 and 47 show the amplifier's forward and reverse isolation in shutdown. The operational amplifier is powered by ± 1.35 -V supplies and configured as a voltage follower ($A_V = 1$). The isolation performance is plotted across frequency using 0.1- V_{PP} , 1.5- V_{PP} , and 2.5- V_{PP} input signals. During normal operation, the amplifier would not be able to handle a 2.5- V_{PP} input signal with a supply voltage of ± 1.35 V since it exceeds the common-mode input voltage range (V_{ICR}). However, this curve illustrates that the amplifier remains in shutdown even under a worst case scenario.

driving a capacitive load

When the amplifier is configured in this manner, capacitive loading directly on the output will decrease the device's phase margin leading to high frequency ringing or oscillations. Therefore, for capacitive loads of greater than 10 pF, it is recommended that a resistor be placed in series (R_{NULL}) with the output of the amplifier, as shown in Figure 49. A minimum value of 20 Ω should work well for most applications.

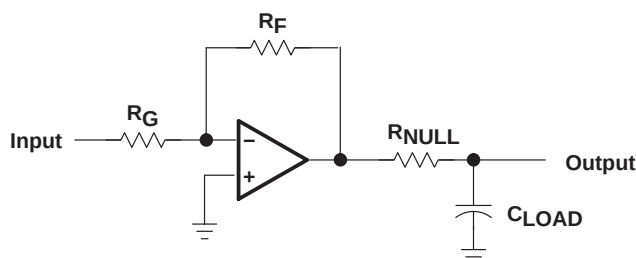


Figure 49. Driving a Capacitive Load

APPLICATION INFORMATION

offset voltage

The output offset voltage, (V_{OO}) is the sum of the input offset voltage (V_{IO}) and both input bias currents (I_{IB}) times the corresponding gains. The following schematic and formula can be used to calculate the output offset voltage:

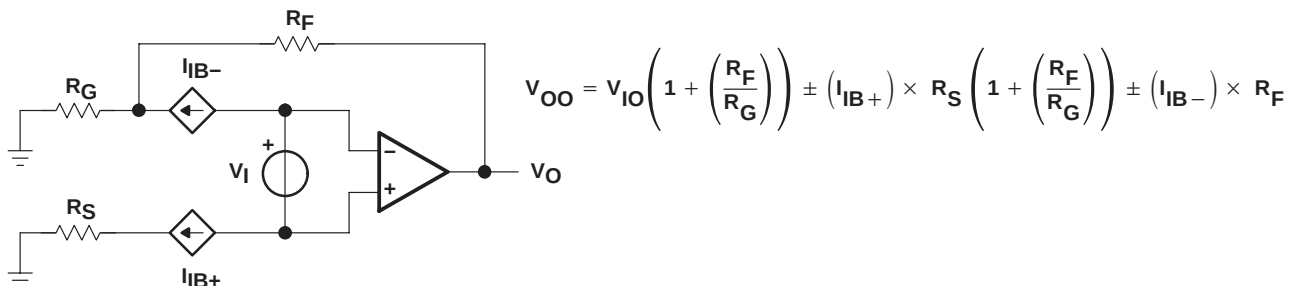


Figure 50. Output Offset Voltage Model

general configurations

When receiving low-level signals, limiting the bandwidth of the incoming signals into the system is often required. The simplest way to accomplish this is to place an RC filter at the noninverting terminal of the amplifier (see Figure 51).

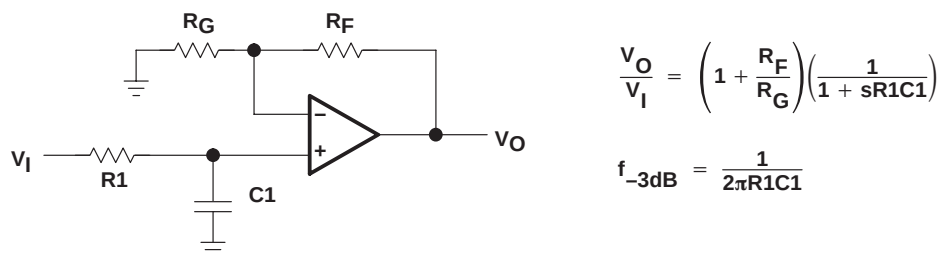


Figure 51. Single-Pole Low-Pass Filter

If even more attenuation is needed, a multiple pole filter is required. The Sallen-Key filter can be used for this task. For best results, the amplifier should have a bandwidth that is 8 to 10 times the filter frequency bandwidth. Failure to do this can result in phase shift of the amplifier.

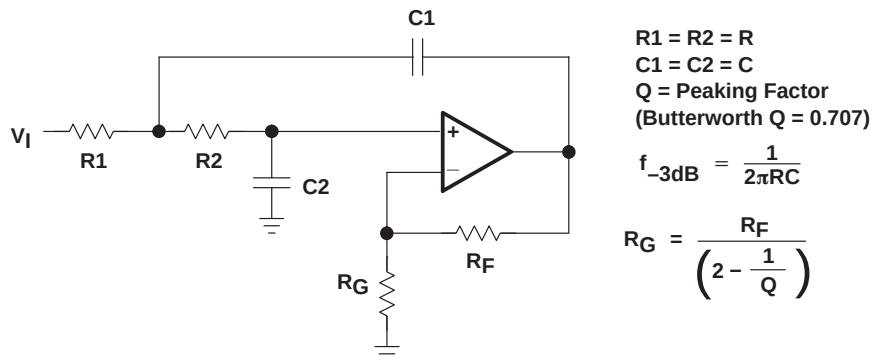


Figure 52. 2-Pole Low-Pass Sallen-Key Filter

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APPLICATION INFORMATION

general power dissipation considerations

For a given θ_{JA} , the maximum power dissipation is shown in Figure 53 and is calculated by the following formula:

$$P_D = \left(\frac{T_{MAX} - T_A}{\theta_{JA}} \right)$$

Where:

P_D = Maximum power dissipation of TLV245x IC (watts)

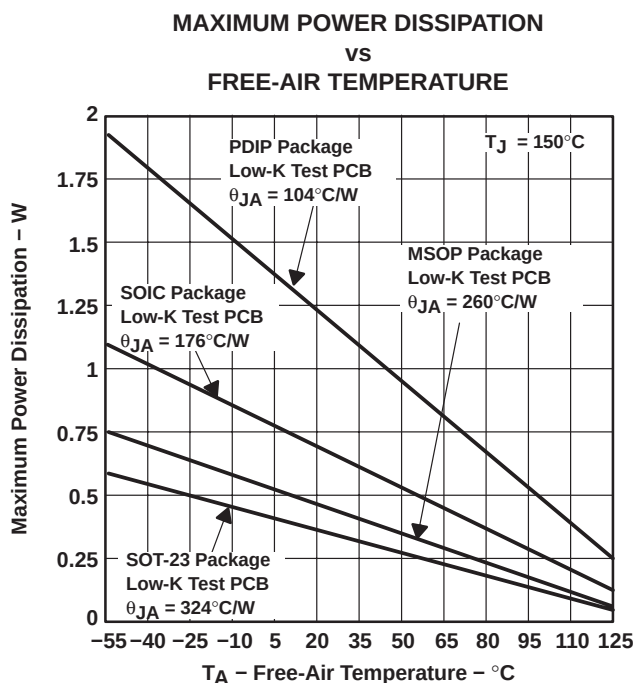
T_{MAX} = Absolute maximum junction temperature (150°C)

T_A = Free-ambient air temperature (°C)

$\theta_{JA} = \theta_{JC} + \theta_{CA}$

θ_{JC} = Thermal coefficient from junction to case

θ_{CA} = Thermal coefficient from case to ambient air (°C/W)



NOTE A: Results are with no air flow and using JEDEC Standard Low-K test PCB.

Figure 53. Maximum Power Dissipation vs Free-Air Temperature

TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT OPERATIONAL AMPLIFIERS WITH SHUTDOWN

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APPLICATION INFORMATION

macromodel information

Macromodel information provided was derived using Microsim *Parts*™, the model generation software used with Microsim *PSpice*™. The Boyle macromodel (see Note 1) and subcircuit in Figure 54 are generated using the TLV245x typical electrical and operating characteristics at $T_A = 25^\circ\text{C}$. Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 1: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers," *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).

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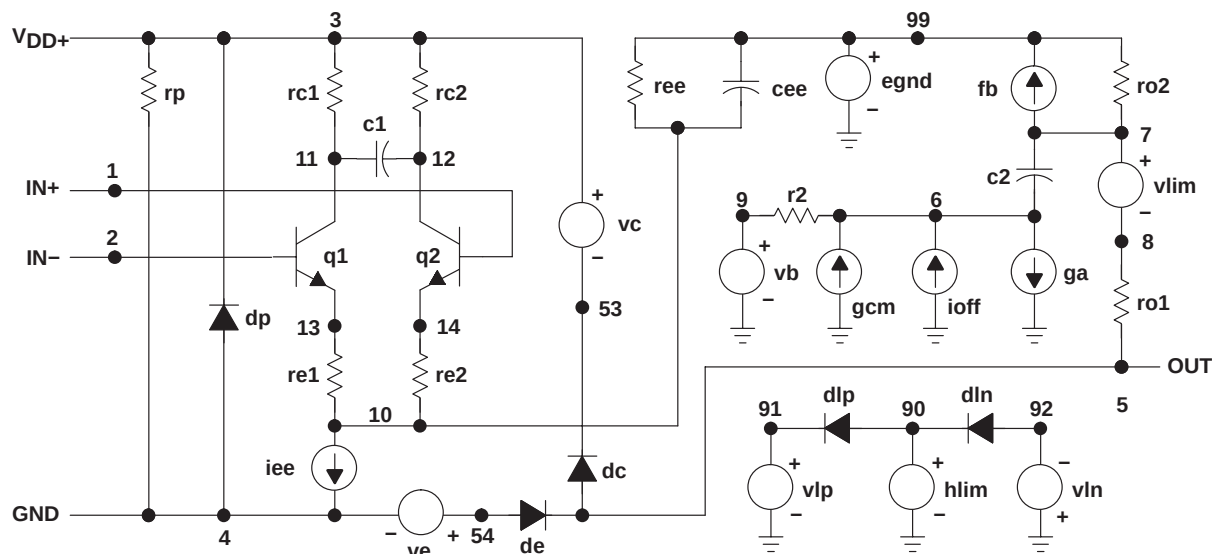
TLV2450, TLV2451, TLV2452, TLV2453, TLV2454, TLV2455, TLV245xA

FAMILY OF 23- μ A 220-kHz RAIL-TO-RAIL INPUT/OUTPUT

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APPLICATION INFORMATION



* AMP_TLV2450-X operational amplifier "macromodel" subcircuit
 * created using Parts release 8.0 on 10/12/98 at 11:06
 * Parts is a MicroSim product.

* connections:

noninverting input
 |
 inverting input
 |
 positive power supply
 |
 negative power supply
 |
 output

.subckt AMP_TLV2450-X 1 2 3 4 5

*

C1	11	12	354.48E-15
C2	6	7	7.5000E-12
CEE	10	99	42.237E-15
DC	5	53	dy
DE	54	5	dy
DLP	90	91	dx
DLN	92	90	dx
DP	4	3	dx
EGND	99	0	poly(2) (3,0) (4,0) 0 .5 .5
FB	7	99	poly(5) vb vc ve vlp vln 0
+ 207.31E6 -1E3 1E3 210E6 -210E6			
GA	6	0	11 12 15.254E-6
GCM	0	6	10 99 48.237E-12

IEE	10	4	dc	938.61E-9
HLIM	90	0	vlim	1K
Q1	11	2	13	qx1
Q2	12	1	14	qx2
R2	6	9	100.00E3	
RC1	3	11	65.557E3	
RC2	3	12	65.557E3	
RE1	13	10	10.367E3	
RE2	14	10	10.367E3	
REE	10	99	213.08E6	
RO1	8	5	10	
RO2	7	99	10	
RP	3	4	147.06	
VB	9	0	dc	0
VC	3	53	dc	.82
VE	54	4	dc	.82
VLIM	7	8	dc	0
VLP	91	0	dc	38
VLN	0	92	dc	38
.model dx D(Is=800.00E-18)				
.model dy D(Is=800.00E-18 Rs=1m Cjo=10p)				
.model qx1 NPN(Is=800.00E-18 Bf=843.08)				
.model qx2 NPN(Is=800.0000E-18 Bf=843.08)				
.ends				

Figure 54. Boyle Macromodel and Subcircuit

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLV2450AID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450AIDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450AIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450AIP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2450AIPe4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2450CD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450CDBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450CDBVRG4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450CDBVT	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450CDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450CP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2450CPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2450ID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450IDBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450IDBVRG4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450IDBVT	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450IDBVTG4	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450IDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2450IP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2450IPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2451AID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451AIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451AIP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2451AIPe4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2451CD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLV2451CDBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451CDBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451CDBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451CDBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451CDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451CDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451CP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2451CPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2451ID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451IDBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451IDBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451IDBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451IDBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451IDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451IDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2451IP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2451IPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2452AID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452AIDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452AIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452AIDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452AIP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2452AIPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2452CD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452CDGK	ACTIVE	MSOP	DGK	8	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452CDGKG4	ACTIVE	MSOP	DGK	8	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLV2452CDGKR	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452CDGKRG4	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452CDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452CDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452CP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2452CPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2452ID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452IDGK	ACTIVE	MSOP	DGK	8	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452IDGKR	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452IDGKRG4	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452IDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452IDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2452IP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2452IPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2453AIDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2453AIDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2453AIN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2453AINE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2453CD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2453CDGS	ACTIVE	MSOP	DGS	10	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2453CDGSR	ACTIVE	MSOP	DGS	10	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2453CDGSRG4	ACTIVE	MSOP	DGS	10	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2453CDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2453CDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2453IDGS	ACTIVE	MSOP	DGS	10	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2453IDGSR	ACTIVE	MSOP	DGS	10	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLV2453IDGSRG4	ACTIVE	MSOP	DGS	10	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2453IDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2453IDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2453IN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2453INE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2454AID	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454AIDG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454AIDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454AIDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454AIN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPD	Level-NC-NC-NC
TLV2454AINE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPD	Level-NC-NC-NC
TLV2454AIPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454AIPWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454AIPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454AIPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454CD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454CN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPD	Level-NC-NC-NC
TLV2454CNE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPD	Level-NC-NC-NC
TLV2454CPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454CPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454CPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454ID	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454IDG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454IDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454IDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454IN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPD	Level-NC-NC-NC

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLV2454INE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2454IPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454IPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2454IPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455AID	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455AIDR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455AIDRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455AIN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2455AINE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2455AIPW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455AIPWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455AIPWRG4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455CD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455CDG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455CN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2455CNE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2455CPW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455CPWG4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455CPWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455CPWRG4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455ID	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455IDG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455IDR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455IDRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455IN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
TLV2455INE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLV2455IPW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455IPWG4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2455IPWRG4	ACTIVE	TSSOP	PW	16		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

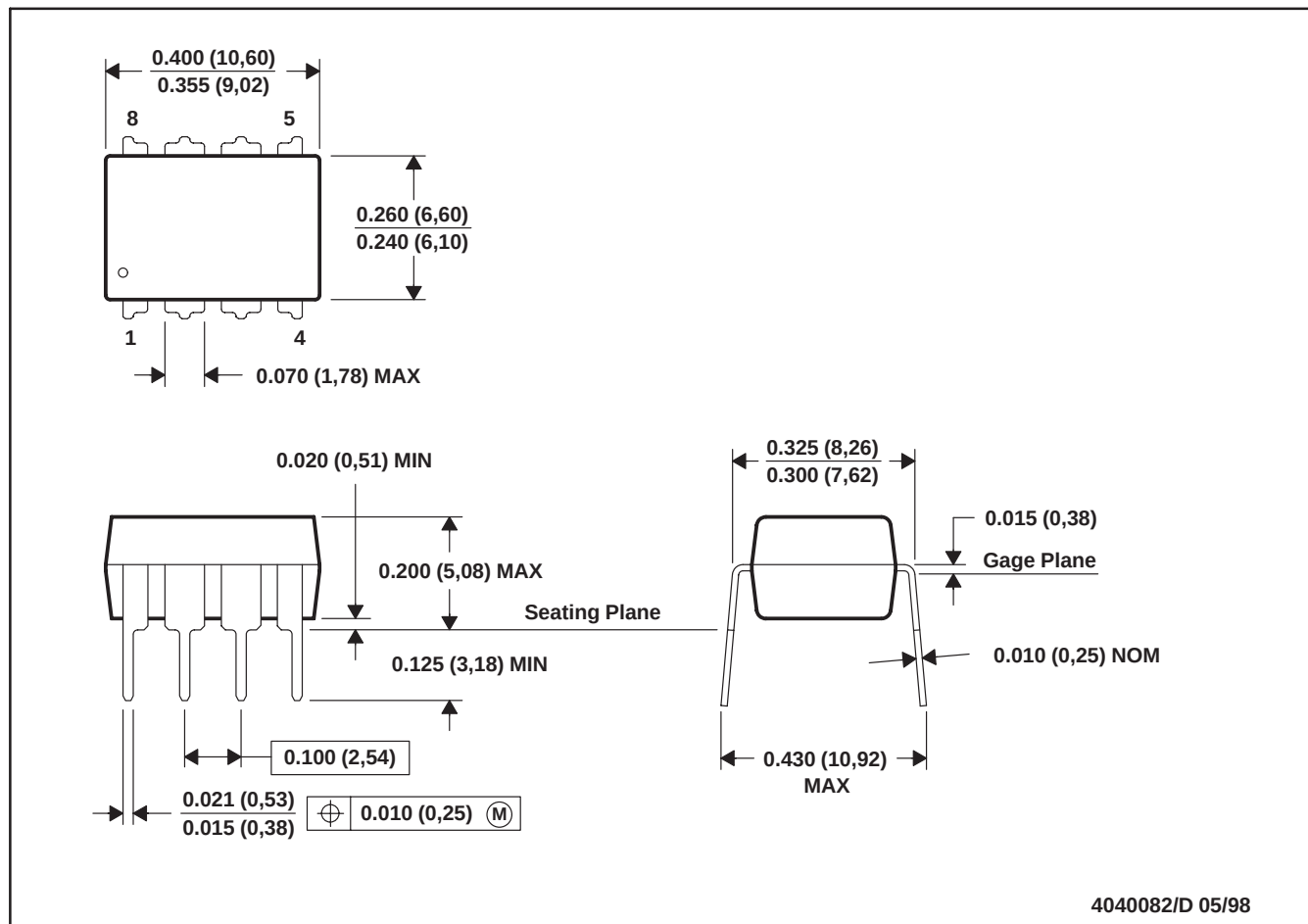
⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Falls within JEDEC MS-001

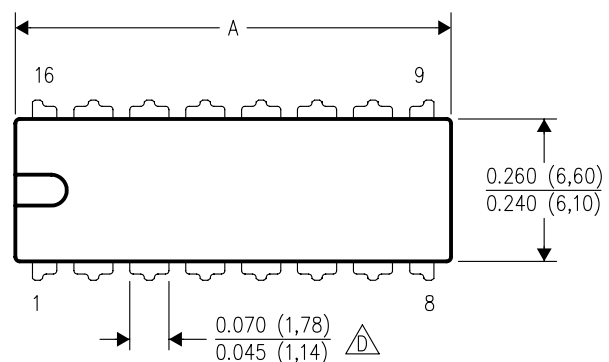
For the latest package information, go to http://www.ti.com/sc/docs/package/pkg_info.htm



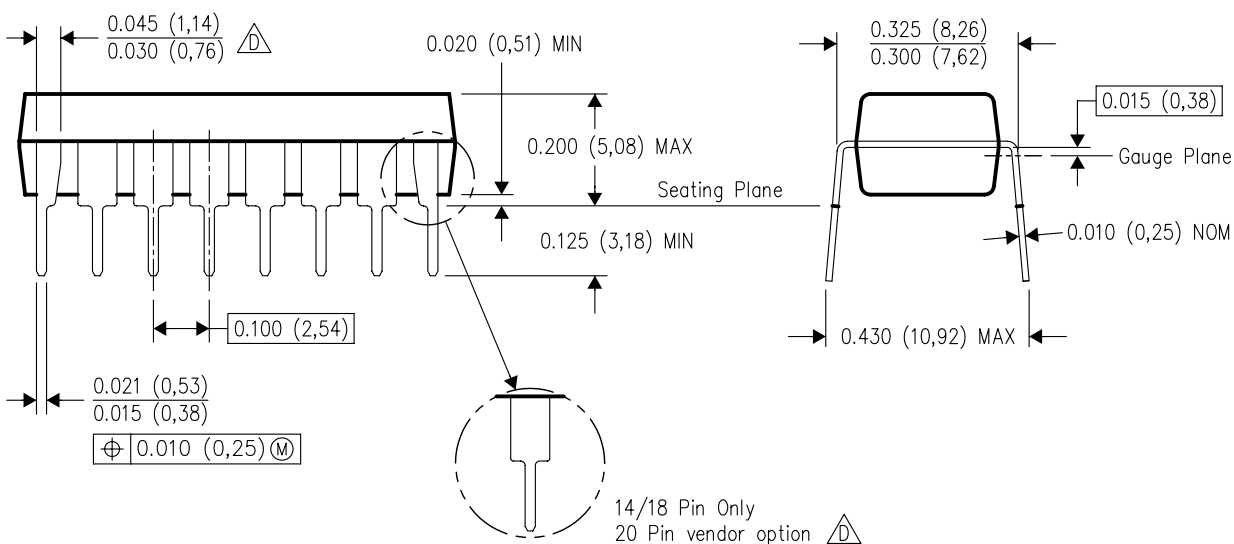
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



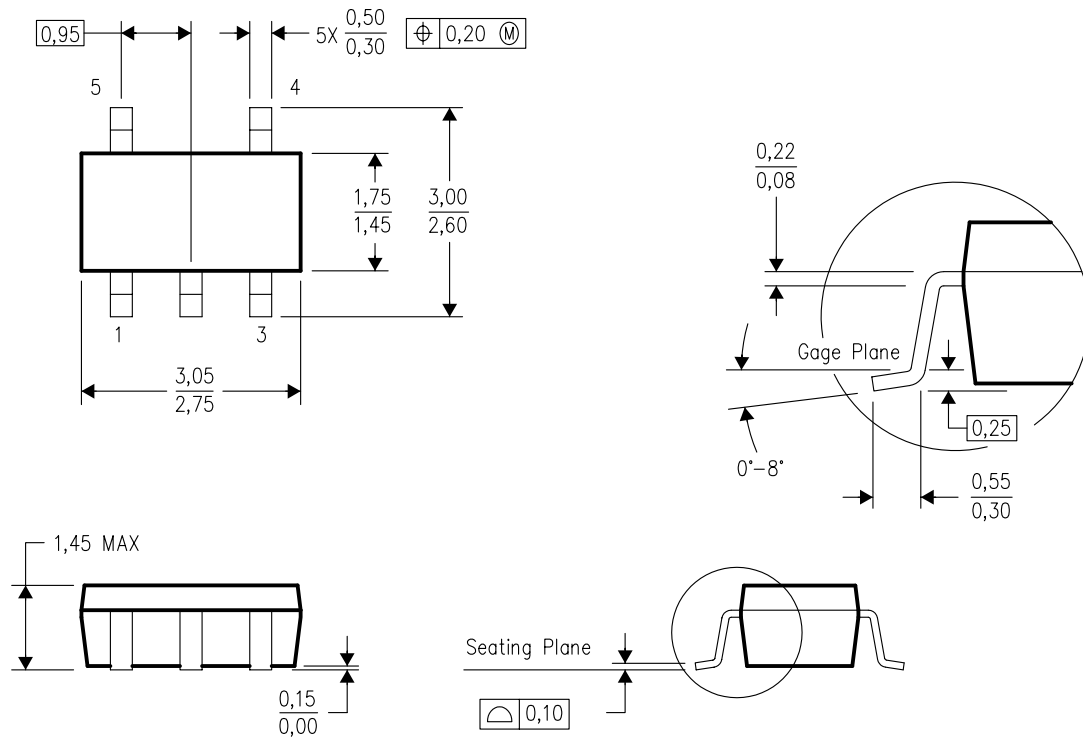
4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE

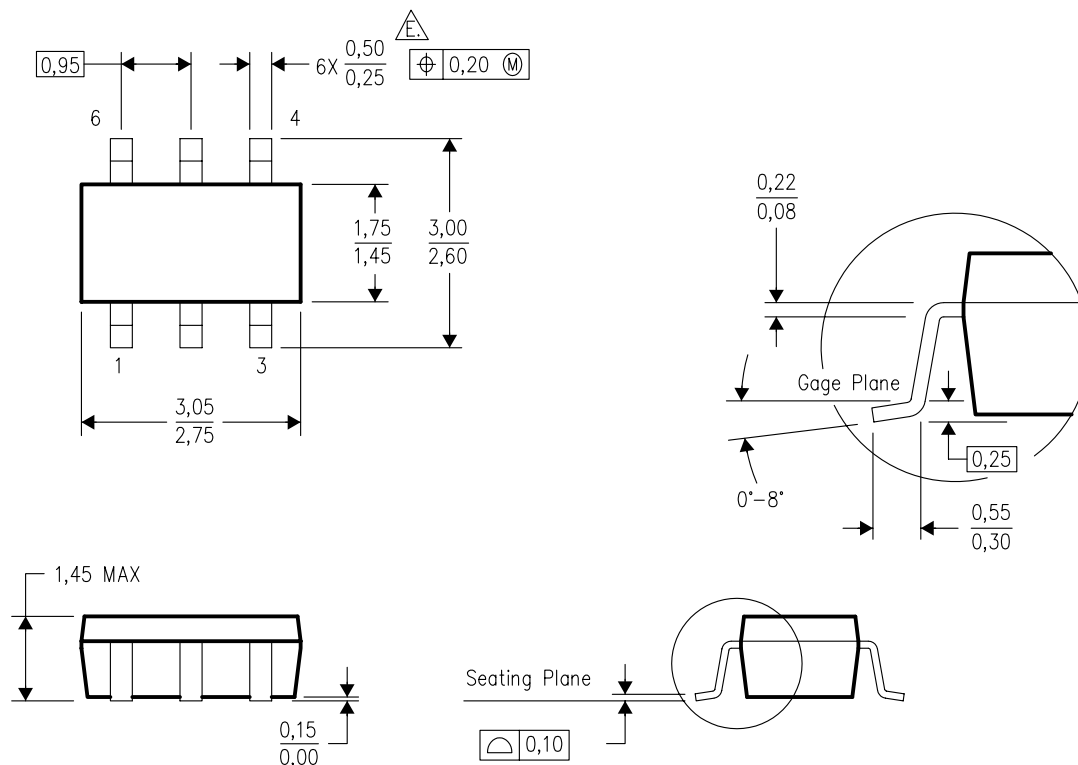


4073253-4/J 10/2005

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-178 Variation AA.

DBV (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE

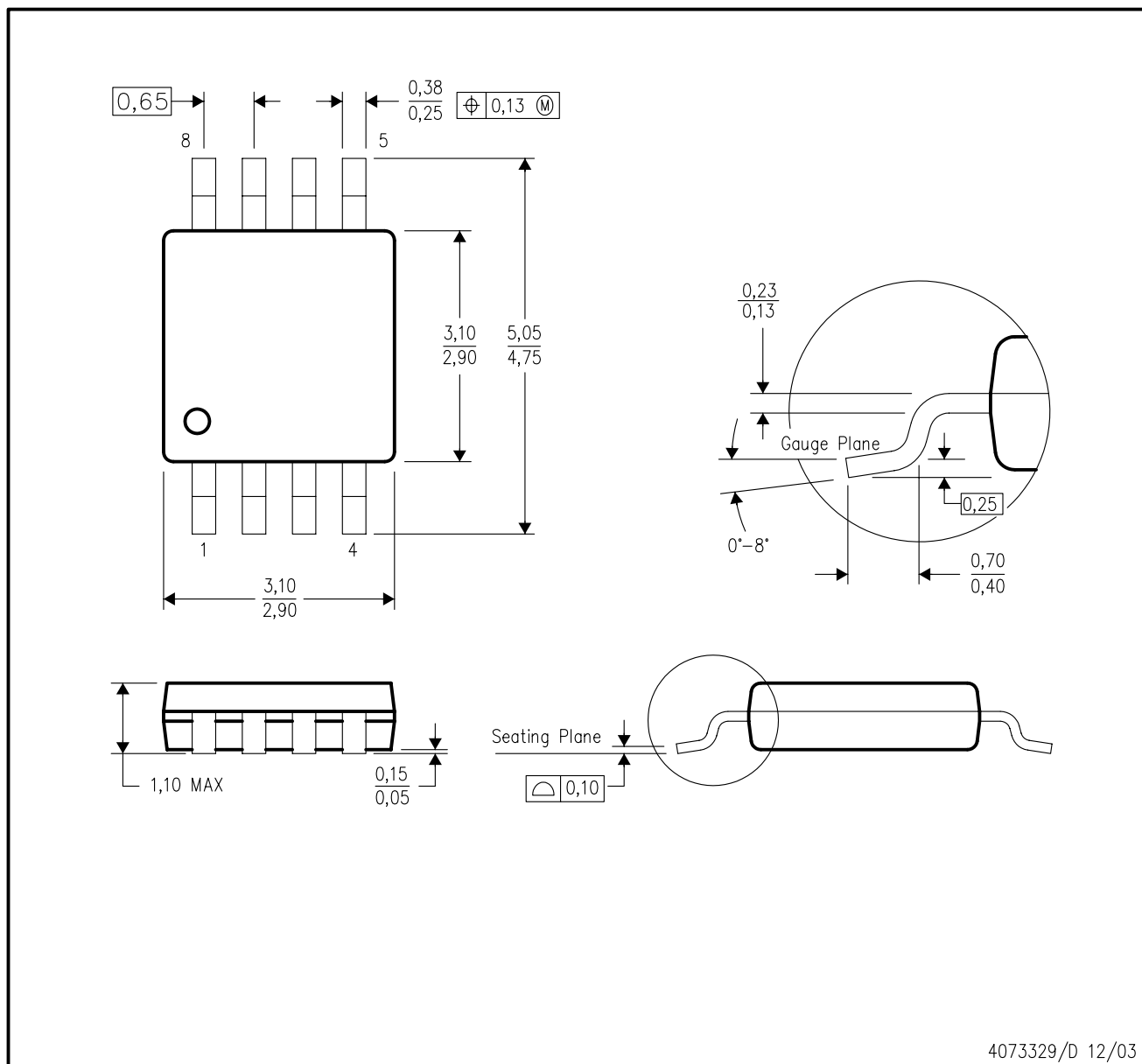


4073253-5/J 10/2005

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
-  Falls within JEDEC MO-178 Variation AB, except minimum lead width.

DGK (S-PDSO-G8)

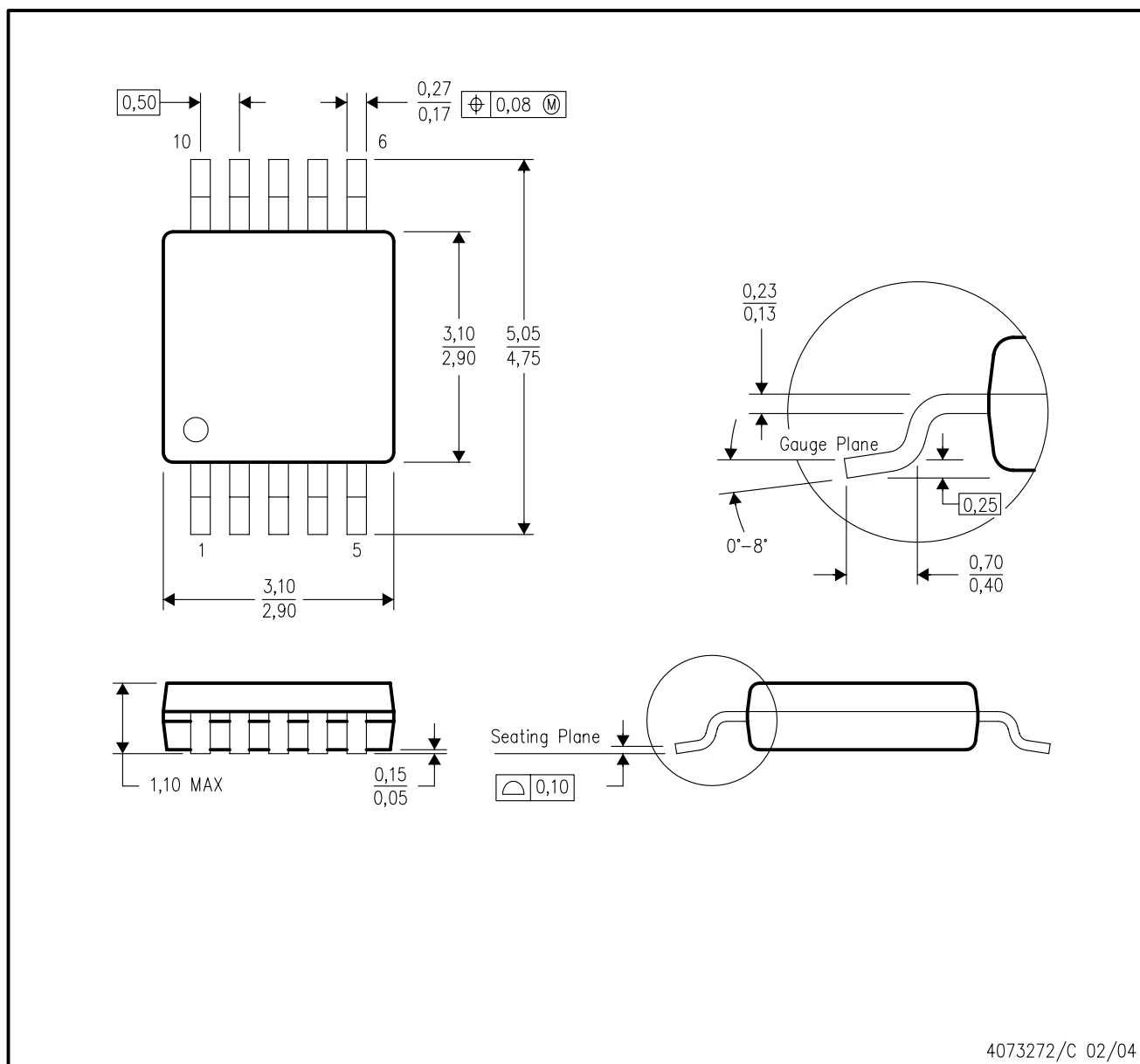
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion.
 - D. Falls within JEDEC MO-187 variation AA.

DGS (S-PDSO-G10)

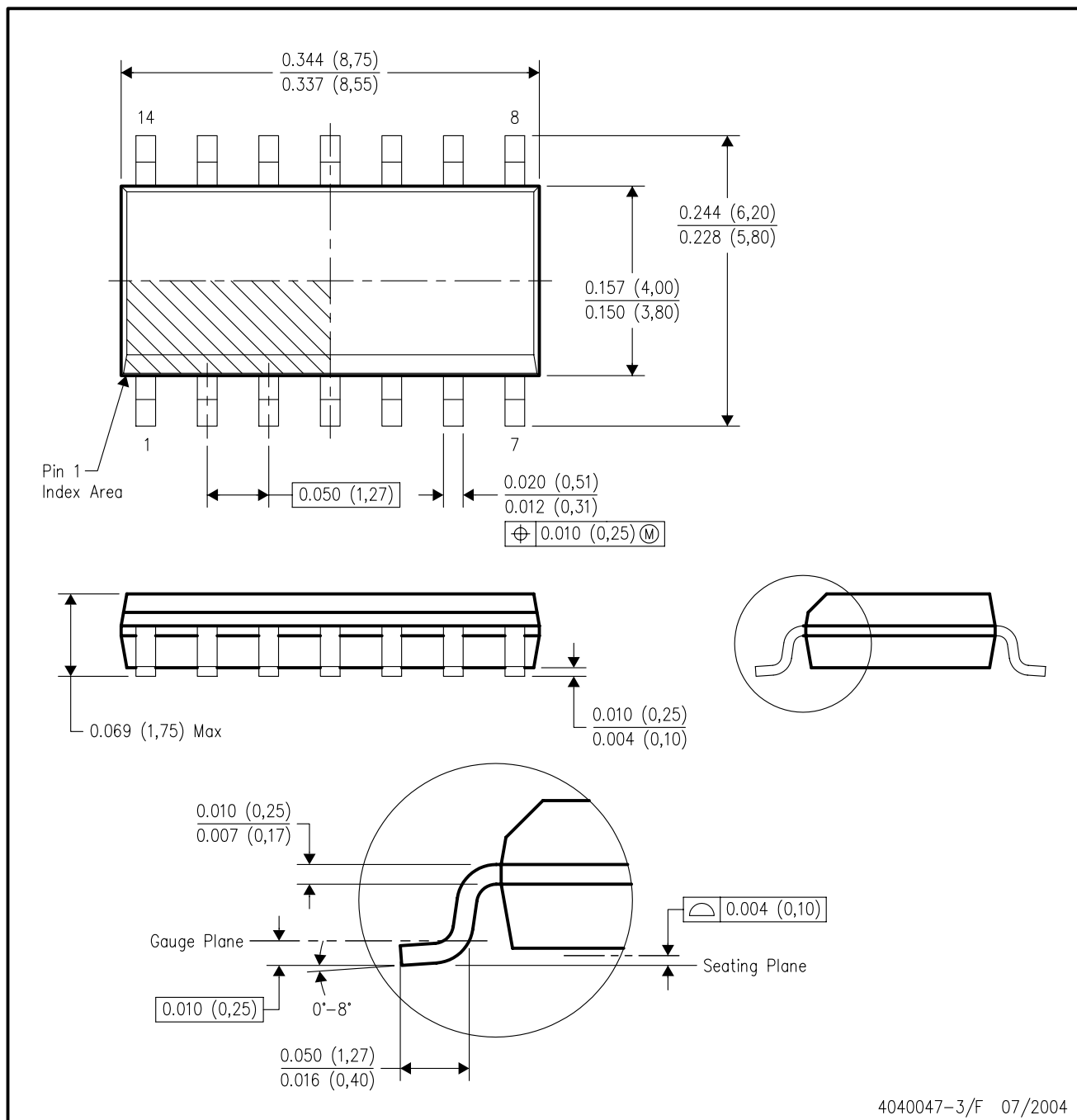
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion.
 - Falls within JEDEC MO-187 variation BA.

D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



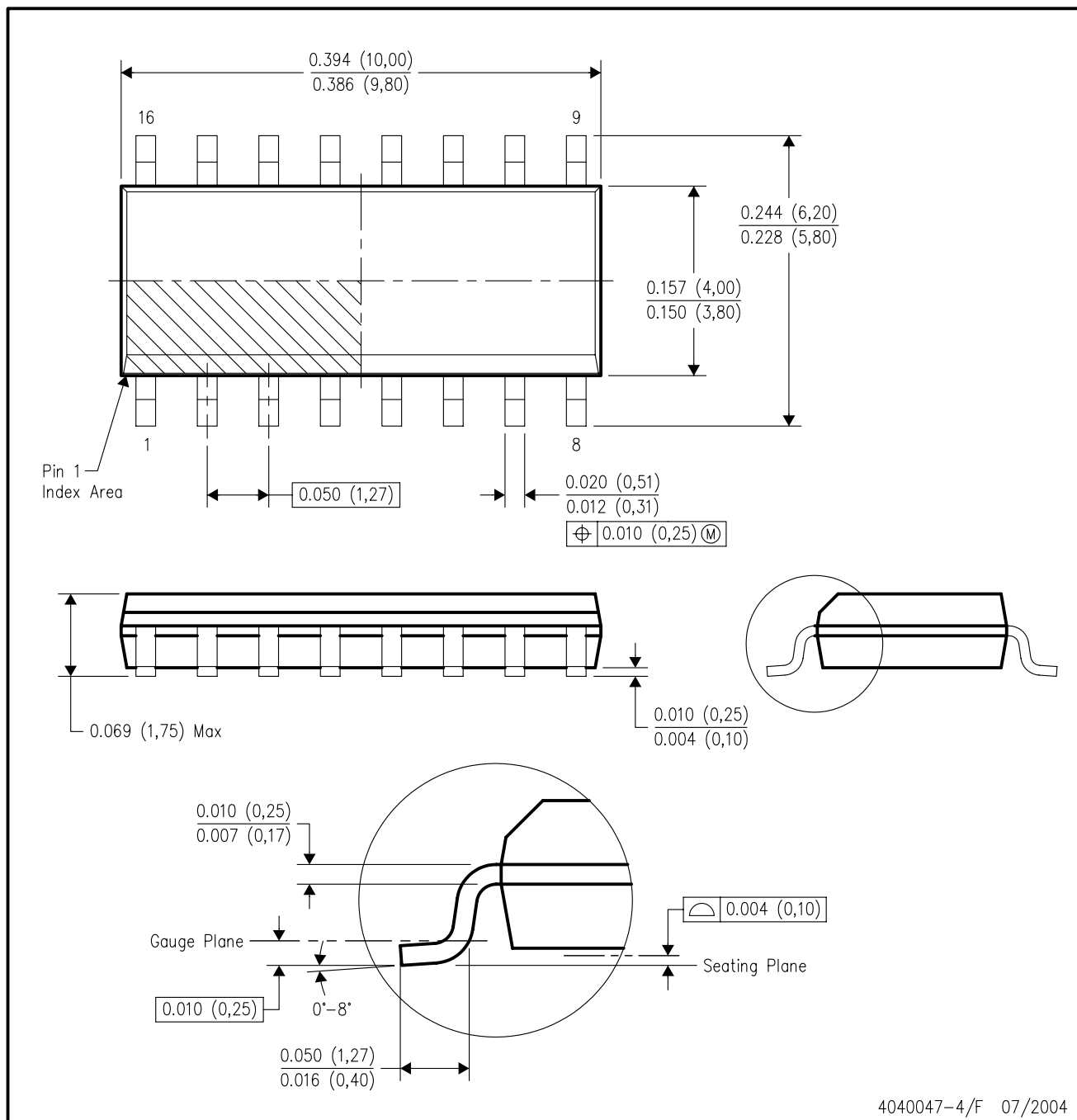
4040047-3/F 07/2004

NOTES:

- All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- Falls within JEDEC MS-012 variation AB.

D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



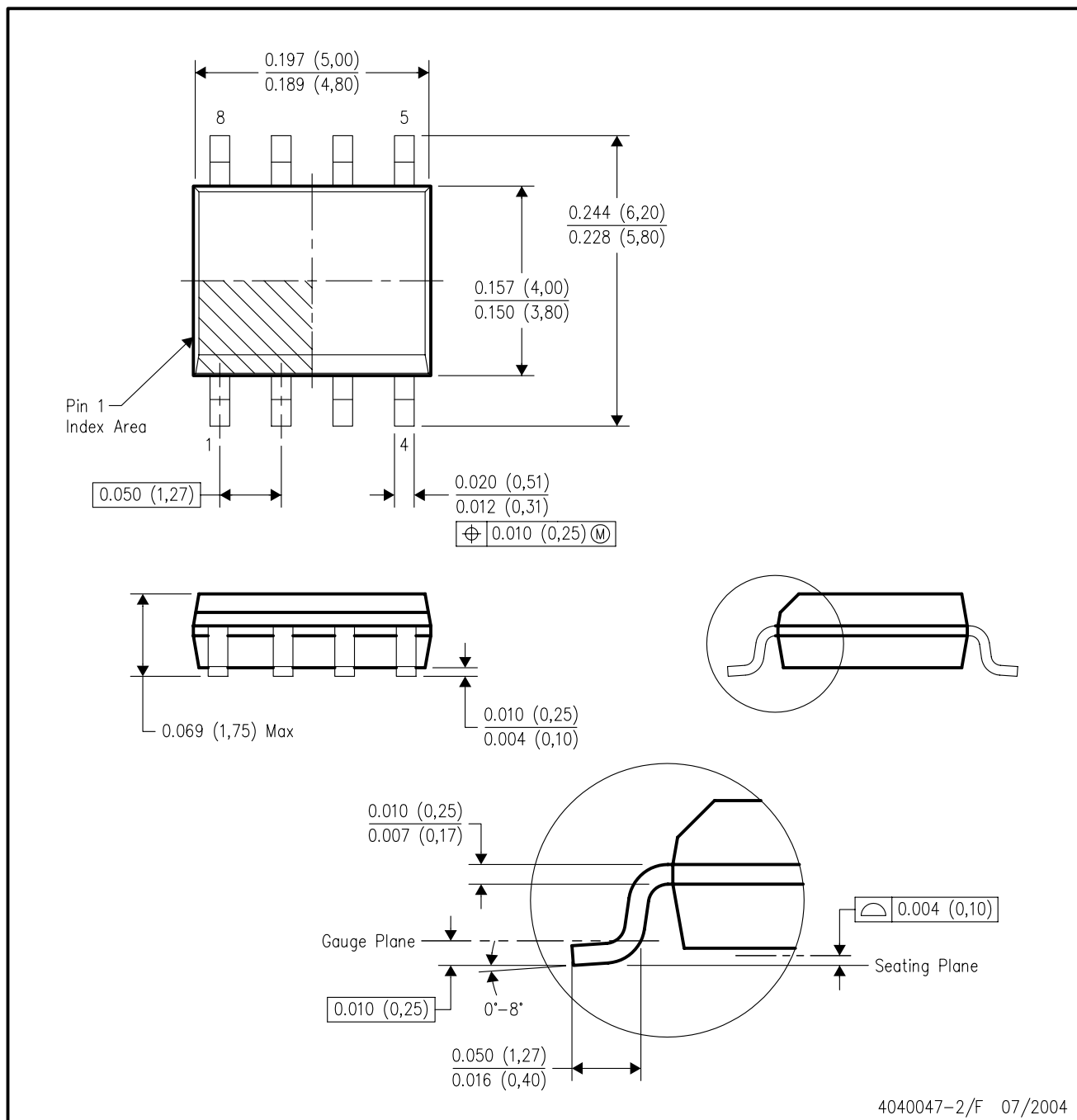
4040047-4/F 07/2004

NOTES:

- All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- Falls within JEDEC MS-012 variation AC.

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE

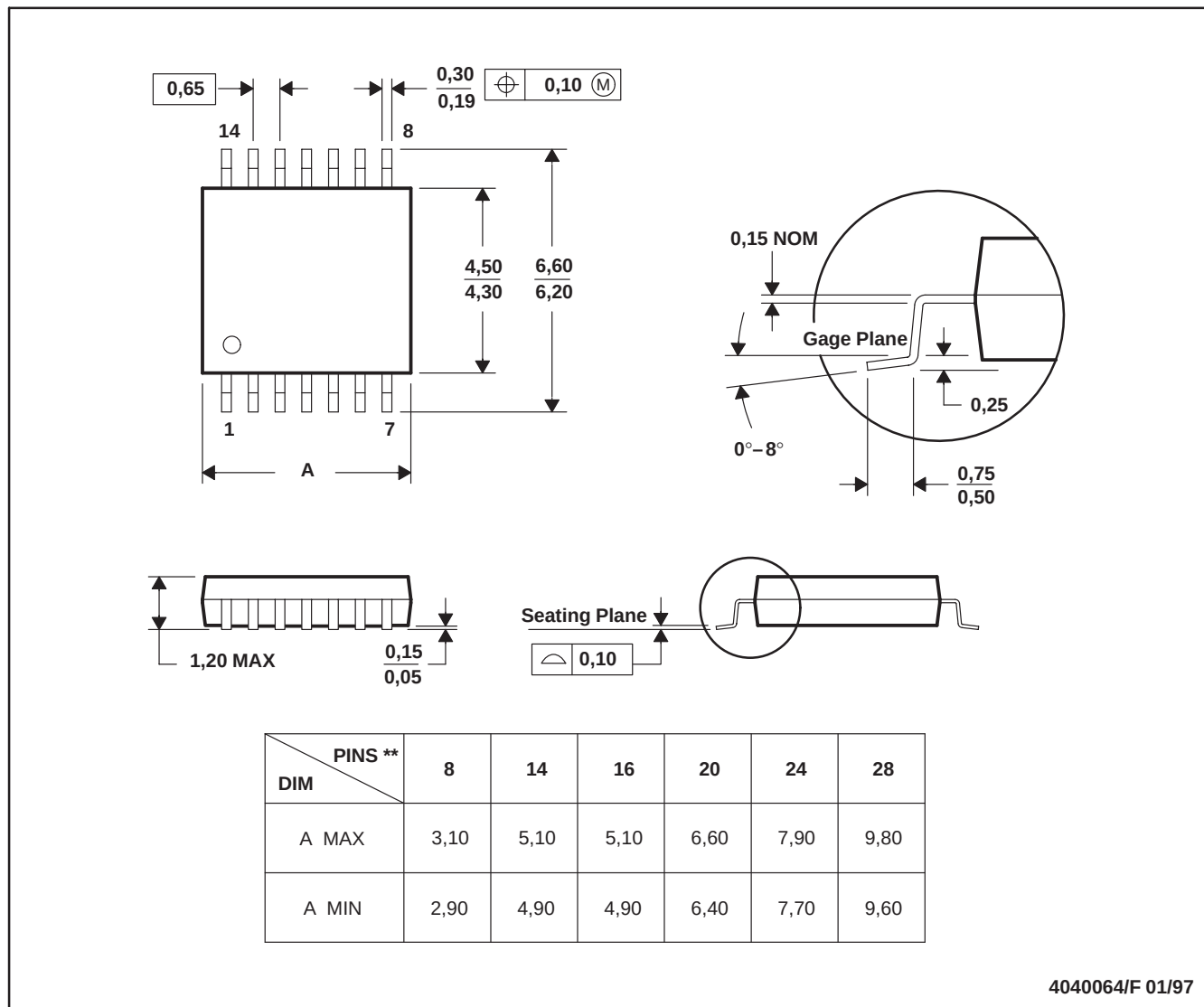


- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MS-012 variation AA.

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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